

Direct Sequence Spread Spectrum (DSSS) Receiver User's Manual

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ABSTRACT

The direct-sequence spread-spectrum (DSSS) receiver performs demodulation of wideband DSSS signals, accepting as input an analogue signal at low intermediate frequency (IF) or baseband, and producing as output the recovered digital message bitstream. It consists of firmware (FW) entities that perform signal processing; a PCI-compliant digital processor card (DPC) that provides analogue to digital conversion and host resources for the FW; and a computer which hosts the DPC and runs software to access, control and monitor it. This manual provides the information required to allow an operator to connect, configure and dynamically control the DSSS Receiver in a precise way to achieve the best demodulation performance.

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DSSS Receiver User's Manual (U)

Executive Summary

The Direct-sequence spread-spectrum (DSSS) Receiver program is a multi-faceted contribution to Defence wireless communications capability – it provides an alternative modulation scheme for special-purpose link scenarios as well as an advanced, reconfigurable, wideband signal processing engine that lends itself to multiple applications, with inherent functional and logistic advantages.

Physically, a single receiver unit consists of the signal processing platform (designated the Digital Processor Card, or DPC) hosted in a computer chassis on the industry-standard PCI bus. The DPC digitises its input signal and provides reconfigurable logic circuits in which a wide variety of digital signal processing algorithms can be implemented.

Functionally, the unit also requires both the signal processing code for the reconfigurable logic (known as firmware) and the application software which lets the host computer communicate with, control and monitor the DPC. Both the firmware and software for the DSSS application are parameterised and run-time configurable.

To exploit this capability then, an operator needs to connect, configure and dynamically control the DSSS Receiver in such a way as to achieve the expected performance. It is the purpose of this manual to adequately define the interfaces and operation of the Receiver to allow this.

Accordingly, this manual includes: definitions of hardware and firmware interfaces; the typical sequence of control and monitoring events following system power-up that lead to valid demodulation in the presence of a continuously transmitted signal; a file-level review of the DSTO DSSS graphical user interface (GUI) and driver software, which includes an example of fully automated set-up and operation; and receiver operating characteristics, in the form of bit error rate (BER) versus signal-quality curves, that indicate the expected performance levels in benign (white noise) channels.

Dissemination of this document will facilitate uptake of the DSSS Receiver capability by Defence personnel and Defence contractors.

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Abbreviations and Acronyms

A Ampere, used with SI prefixes

AC Alternating current

ADC Analogue-to-digital converter
AFC Automatic frequency control
AFF Asynchronous feed-forward
AGC Automatic gain control

AWGN Additive white Gaussian noise

BB Baseband
BER Bit error rate

BITE Built-in test equipment

bps Bits per second, used with SI prefixes

BPSK Binary phase-shift keying

CMOS CMOS semiconductor technology CORDIC COordinate Rotation DIgital Computer

dB Decibel

DC Direct current

DCC Data conversion and clockingDDC Digital down-conversionDDP Digital data processor

DDS Direct digital synthesis/synthesiser

DPC Digital processor cardDSP Digital signal processing

DSSS Direct sequence spread spectrum

DSTO Defence Science and Technology Organisation

DQPSK Differential QPSK

EEPROM Electrically erasable/programmable read-only memory

ELDLL Early-late gate delay-locked loop

EPLL Enhanced PLL

FIFO First-in, first-out memory buffer FIR Finite impulse response (filter) FPGA Field-programmable gate array

FW Firmware

GBBM Generic baseband modem (a legacy designation for the

DPC)

G_p Processing gain (in a spread spectrum system)

GUI Graphical user interface

HW Hardware

Hz Hertz (cycle/second), used with SI prefixes

I/O Input/Output

IF Intermediate frequency

JTAG Joint Test Action Group Interface standard

LFSR Linear feedback shift-register

LO Local oscillator

LPD Low probability of detection

LPF Low-pass filter

LSB Least significant bit/byte
LSW Least significant word
LVCMOS Low-voltage CMOS

LVDS Low-voltage differential signalling

m Metre, used with SI prefixes

MB Megabyte

MCPS Mega-chips per second
MSB Most significant bit/byte
m-sequence Maximum-length type PRBS

MSW Most significant word

NCO Numerically-controlled oscillator O(x) A value "of the order of " x

PC Personal computer

PCI Peripheral component interconnect bus standard

PLL Phase-locked loop PN Pseudo-noise ppm Parts per million

PRBS Pseudo-random binary sequence
QPSK Quaternary phase-shift keying

RF Radio frequency
RRC Root-raised cosine

s Second, used with SI prefixesSNR Signal-to-noise power ratio

SPS Samples per second, used with SI prefixes

STR Symbol timing recovery

SW Software

.ttf Tabular text file formatV Volts, used with SI prefixes

VHDL Very high speed integrated circuit Hardware Description

Language

 Ω Ohms

1. Introduction

1.1 Scope

This document is the User's Manual for the Direct-sequence Spread-spectrum (DSSS) Receiver developed by the Secure Communications Branch of the Defence Science and Technology Organisation (DSTO).

The DSSS Receiver performs demodulation of wideband DSSS signals, accepting as input a spread analogue signal at low intermediate frequency (IF) or baseband, and producing as output a despread message bitstream in digital form. It consists of DSSS firmware (FW) entities (in VHDL) that perform signal processing; a PCI-compliant digital processor card (DPC) that provides analogue to digital conversion (ADC) and FPGA resources for the FW; a computer with a PCI-bus which hosts the DPC; and driver and interface software (SW) for control and monitoring of the FW application.

The operator needs to connect, configure and dynamically control the DSSS Receiver in a precise way to achieve the best demodulation performance. This manual provides the following information to facilitate such operation:

- Definitions of hardware (HW) and FW interfaces.
- The typical sequence of control and monitoring events following system power-up that lead to valid demodulation in the presence of a continuously transmitted signal.
- A file-level review of the DSTO DSSS graphical user interface (GUI) and driver software, which includes an example of fully automated Receiver set-up and operation.
- Receiver operating characteristics, in the form of bit error rate (BER) versus E_b/N_o curves, that indicate the expected performance levels in benign (AWGN) channels.

In the remainder of this introduction, the fundamental physical and logical components of the Receiver and the basic concepts of operation will be reviewed. Then in Section 2, the Receiver's interfaces, both physical and functional, will be described. Many of the interfaces are defined in FW and accessed over the PCI bus. These include configuration registers, status registers and signal capture channels, for which interface definitions are given in Sections, 3, 4 and 5 respectively. With these interfaces, a method of operation is described in Section 6. For this approach many of the suggested algorithms have already been coded into functional SW in the form of a Development GUI, and this application is described in Section 7.

Due to the highly reconfigurable nature of the DPC and its FW applications, the applicability of this manual is restricted to the specific Receiver configuration given in Appendix A.

1.2 Overview

1.2.1 The DSTO Digital Processor Card (DPC)

The DSTO DPC is a highly configurable and computationally powerful signal processing engine. It consists of a mainboard with up to four plug-in modules.

The mainboard is a universal (3.3v or 5v) PCI plug-in card with extended length form-factor that supports 64/32-bit and 66/33- MHz modes of operation and is compliant with revision 2.2 of the PCI standard. The mainboard features include:

- A PCI Interface Target, implemented as a custom FW entity in an Altera EP1S10F484C5 FPGA. This device is configured at boot-time from an Altera EPC8QC100 configuration EEPROM in fast passive-parallel mode.
- Four module sites designated Slot#0 to Slot#3, each of which can host a plug-in module. A pair of high-density connectors for each slot facilitates Target-to-Slot, Slotto-Slot (adjacent Slots only) and power rail connectivity.
- Back-end (application-side) PCI signalling between the Target and the Slots, allowing PCI access to each plug-in module.
- Custom signalling between the Target and the Slots, intended primarily as an FPGA configuration bus when plug-in modules contain volatile FPGAs.
- JTAG interfacing to the Target and Slots. There are independent 3.3v and 1.5v JTAG chains accessible via the same 12-pin header. The 3.3v chain is for the PCI Target FPGA and its configuration EEPROM, whereas the 1.5v chain is for Altera Stratix-type FPGAs in the Slots.
- Local power generation and conditioning, using custom switching supply circuits with the PCI power rails as inputs.
- A PCI back-panel with analogue I and Q inputs (SMA F/M), a reference frequency output (SMA F/M), and a JTAG port (12-pin header, M).

There are two plug-in modules pertinent to the DSSS Receiver, namely a Data Conversion and Clocking (DCC) module and a Digital Data Processing (DDP) module.

The DCC is essentially an ADC module, and also provides the primary signal processing clock. It features:

- High-stability clock generation and distribution. It provides a fixed-rate, 200 MHz sample clock with 100ppm stability and 1ps of $1-\sigma$ phase jitter.
- Two channels of synchronous analogue to digital conversion with 10-bit, 200MSPS ADC devices identified as the in-phase (I) and quadrature-phase (Q) channels (consistent with application in quadrature signalling schemes). The ADC output on each channel is presented in a demultiplexed form at half rate, together with a sample-synchronous 100 MHz output clock. The demultiplexed channels are designated as channel A and channel B, leading to four 100MSPS output streams designated IA, IB, QA and QB, each with 10-bit resolution.

- External (adjacent Slot) control of the ADC enable, output data format and output data interleaving controls.
- Local power generation and conditioning.

The DDP is the main signal processing engine, hosting a high-density FPGA for FW-based operations. It features:

- An Altera EP1S80F1508C6 FPGA. This provides approximately 80,000 LE, 7,427kbit RAM, and 22 embedded DSP Blocks for up to 176 x 9-bit multipliers. It supports clock rates in excess of 200 MHz.
- Connection to the mainboard back-end PCI and configuration buses.
- High-density signalling to adjacent Slots.
- A 42-way LVDS (or 84-way LVCMOS) Digital Input/Output (I/O) Header for general purpose I/O.
- Local power generation and conditioning.
- Test headers.

When hosting the DSSS Receiver FW, the DPC would normally be configured with a DCC in Slot#0 and a DDP in Slot#1.

1.2.2 DSSS signalling and the DSTO Receiver Architecture

This manual does not provide a technical introduction to DSSS signals and systems, but does assume familiarity with key concepts such as spreading signal generation and modulation, processing gain (G_p) , the processes inherent in spread signal demodulation such as acquisition, tracking and despreading, and QPSK modulation principles.

The DSTO DSSS transceiver is a noncoherent, burst-capable simplex link optimised for low probability of detection (LPD), fast acquisition, high data rates and simple transmitter architecture.

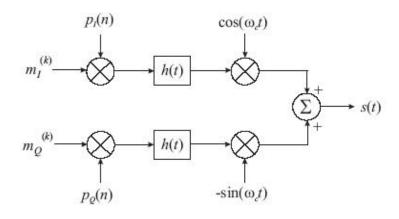


Figure 1- DSSS Transmitter Architecture

On the transmit side, the signal varies from conventional DQPSK only through the independent (but synchronous) spreading of each of the I and Q components of the symbol prior to upconversion, as shown in Figure 1. Referring to this figure, note the following:

- This is an unbalanced modulator, in which different signals are applied to the I and Q channels, allowing the higher spectral efficiency of QPSK (relative to BPSK) to be utilised but requiring specialised processing to facilitate despreading in the presence of frequency errors.
- The QPSK message symbol $m = m_1 + j^*m_Q$ is differentially encoded. The following Karnuagh maps define the encoding process, with the input symbol stream given by $S(n) = I_n + j^*Q_n$:

$\underline{\mathbf{m}}_{\mathbf{I}}$		I_{n-1}/Q_{n-1}			
	I_n/Q_n	00	01	11	10
	00	0	1	1	0
	01	1	1	0	0
	11	1	0	0	1
	10	0	0	1	1

$\underline{\mathbf{m}}_{\mathbf{Q}}$		I_{n-1}/Q_{n-1}			
	I_n/Q_n	00	01	11	10
	00	0	0	1	1
	01	0	1	1	0
	11	1	1	0	0
	10	1	0	0	1

- The spreading codes p_I and p_Q should be m-sequences of up to 16th order (65535 chips in length).
- The spreading codes should be of the same order to minimise acquisition time, but should have different sequences and initial phases to allow discrimination between the I and Q channels in the presence of frequency error at the receiver.
- The Receiver supports spreading rates up to 50 MCPS, but could have its FW "place and route" optimised to support at least 100 MCPS.
- The symbol rate can be up to 2MSPS (4 Mbps) at 50 MCPS or 4MSPS (8 Mbps) at 100 MCPS. At these rates the processing gain for demodulation is $G_p = 14$ dB.
- The symbol rate should be chosen with respect to the spreading rate to give an integer number of chips per symbol (equal to the processing gain G_p) but need not be otherwise synchronised with the spreading codes. This allows a very long and noise-like PRBS to be used with very short symbols, preserving the desired LPD spectral properties even at high data rates, but requires specialised symbol timing recovery at the receiver.

On the receive-side, the architecture is shown in Figure 2. A representative RF Downconverter stage is shown at the top of this figure, and serves to provide a quadrature baseband or low-IF signal r(t) to the DPC.

Following the signal processing path, the received signal is then anti-alias filtered (analogue LPF with fc = $140\,\mathrm{MHz}$) and digitised at 200MSPS with 10-bit resolution. Each of the I and Q channels are independently but synchronously sampled.

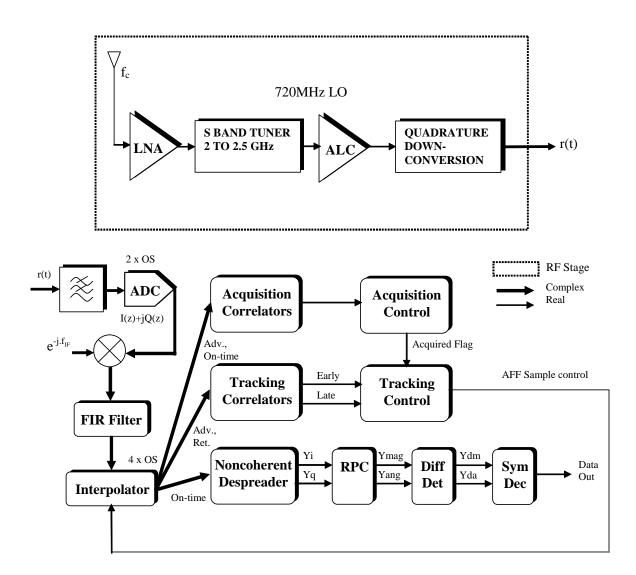


Figure 2- DSSS Receiver Architecture

A digital downconversion (DDC) stage follows in which the full-rate complex signal is downconverted by mixing with a FW-generated complex numerically controlled oscillator (NCO). The NCO has a 32-bit, dithered phase accumulator, providing fine frequency resolution and good spurious suppression in the downconversion.

Sample rate decimation occurs at chip rates less than 100 MCPS. The DCC HW always samples at 200MSPS, but the DSSS FW expects minimum (x2) over-sampling of the chip rate, which facilitates the maximum possible chip rate for a given ADC capability. The decimation

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scheme only permits chip periods of 20ns or longer in 10ns increments, which is a constraint that facilitates decimation without the FW complexity of high rate interpolated resampling.

The signal is then root raised-cosine (RRC) match-filtered to the expected chip pulse shape with finite impulse response (FIR) filters (or just lowpass filtered if the transmitted pulses are not matched). These filters have a multi-rate architecture and multiplier-free implementation which facilitates high throughput but conserves FW resources. These filters may be bypassed under FW control.

Linear interpolators then up-sample the signal to 4 samples per chip. This was established by design to be the minimum sufficient sample rate for good tracking performance and hence good demodulator BER. The interpolators span a sliding window of 5 input samples, producing all the "in-between" samples to give an output set of eight interpolated samples. Three of these output channels at ½-chip relative offsets, designated 'advanced', 'on-time' and 'retarded', are selected under the control of the tracking loop, and used variously for the remaining demodulation processes. Note that each interpolated channel here is still a spread, complex signal and may have timing errors in both the carrier domain (a frequency error f_e , typically referred to as noncoherence) and in the modulation domain (a chip rate error R_e , typically referred to as synchronisation error).

Of the interpolated outputs, the on-time and advanced are used as inputs to the acquisition circuits, the advanced and retarded are used as inputs to the tracking circuits, and the on-time is processed for demodulation.

Spreading code acquisition is the first process that must occur to facilitate demodulation. The acquisition circuits consist of acquisition correlators and an acquisition controller. To minimise the mean acquisition time in support of burst transmissions, the correlators have a parallel architecture and the longest length that could be implemented in the first generation of DPC hardware. To reduce the variance in the acquisition time, two channels of interpolated output are tested simultaneously, in the so-called on-time and advanced correlators. To permit noncoherent correlation a sum-of-squares (envelope) style test is made. The correlators can be configured for different internal arrangements which are trade-offs between correlation length and number of effective bits of the input samples used in the correlation. The arrangement 512 x 1-bit is effective for most scenarios and provides correlation testing with 27dB of processing gain.

To initialise acquisition testing, the controller will preload correlator code registers with known phases of the local spreading codes, disable code register clocking to maintain those code phases, and reset an acquisition state tree (dwell tree) to the zero (bottom) state, representing the unacquired condition. On every subsequent chip-clock event, sampled data is clocked in to correlator data registers and a comparison is made between the code and data register contents, producing a correlation score with a pipeline delay. The controller compares the correlation scores from both the on-time and advanced correlators against a user-defined threshold and if either exceeds the threshold it advances the dwell state and enables clocking of the code registers with a phase advanced copy of the local spreading codes (to compensate for pipeline latency). The correlation score is retested after the code and data registers have flushed stale data (which takes as many chip clocks as the correlators are long), and then

retested periodically at this rate. Every time the threshold for the current dwell is exceeded the dwell state is incremented, otherwise it is decremented. If the dwell state reaches a user-defined height then acquisition is declared. If the dwell state reaches zero again, then acquisition fails and the process is repeated.

To compensate the chip error R_e a tracking loop is required. The tracking loop has a conventional early-late gate delay-locked loop (ELDLL) architecture. A noncoherent correlation against both the advanced and retarded timing phases out of the interpolator is performed against the current local code phases following acquisition. These correlators have a serial (accumulator-like) architecture, giving a new result once per accumulation period (or dwell) as specified by the user. The difference between the advanced and retarded test results is an error signal that, after smoothing and scaling, can be used to change the interpolator channel selections to maintain the on-time channel at the optimum sampling instant. Since there are 4 samples per chip after interpolation, the tracking loop timing accuracy is (+/-) $1/8^{th}$ of a chip. Also, the tracking loop can make at most three state adjustments in one direction before the desired timing point crosses a chip boundary, in which case the local spreading code phases must be incremented or decremented by 1 clock.

When the tracking loop gain is correct, the on-time channel from the interpolators will represent the received signal with 1 sample per chip at the best available sampling instant, and can be input to the demodulation chain for despreading and QPSK demodulation. Note that up to this point there are no feedback loops for carrier or clock recovery, and hence no associated loop synchronisation delays. This architecture, which has been described as an asynchronous feed-forward (AFF) architecture, was chosen in support of rapid processing for burst signalling, and to allow operation at very low SNR where timing recovery circuits can be ineffective.

In the demodulation chain, the despreader cannot use envelope-style correlators without masking the underlying symbol. Accordingly an alternative noncoherent despreader which preserves the modulation content was developed. This allows noncoherent operation, but has a 3dB performance penalty when compared against a coherent equivalent. The despreader is based on serial correlators, with accumulation time equal to the number of chips per symbol. Its output, at 1 sample per symbol, is a DQPSK symbol with 16-bit real component on the I-channel and 16-bit imaginary component on the Q-channel.

As the despreader correlators are of the accumulation type they require a sample and dump timing strobe, which is in fact the synchronised symbol-rate clock. This symbol clock is also required for the remainder of the DQPSK demodulation. The symbol clock rate is known from the chip timing and fixed number of chips per symbol, but the clock phase is initially unknown. A symbol timing recovery (STR) loop operates in parallel with the despreader to find the required phase. It employs noncoherent despreaders operating at assumed optimal and offset sampling phases to generate an error signal that, after smoothing and scaling, can be used to drive the actual sample phase to the correct point.

Demodulation of the DQPSK symbol stream follows conventional algorithms. This FW implementation first uses a CORDIC rotator to convert the symbol from rectangular to polar

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coordinates. Differential detection is then computationally simple, and yields the difference angle Y_{da} , at one sample per symbol, which can be decoded to recover the message bitstream.

Automatic gain control (AGC) and automatic frequency control (AFC) are ancillary functions not shown explicitly in Figure 2.

AGC is available immediately after sampling from a control loop that senses overflow events in the sampled data. The application of the AGC loop output to the actual control of attenuators in the RF Downconverter will depend on the specifics of the downconverter used.

AFC is available after differential detection from a control loop that strips the modulation from the differentially detected angle and averages the result to estimate a mean $f_e.$ A correction '- f_e ' to the DDC downconversion frequency can then effect frequency control. The AFC loop algorithm has a finite deterministic detection range of $-R_s/8 \le f_e \le +R_s/8$, where R_s is the symbol rate. Actual errors outside of this range 'fold back' into this range and can lead to 'tracked errors' at multiples of $R_s/4$. Note that the AFC loop output is only valid when the decoded DQPSK signal is valid, hence AFC should be disabled until acquisition, tracking, and possibly data verification, have been achieved.

1.2.3 DSTO DSSS Receiver Operations Summary

This section provides a brief summary of normal operation of the DSSS Receiver.

Operation starts at power-up. Since the Stratix FPGAs on the DPC are volatile, they will be unconfigured at power-up, with all user I/O pins tri-stated. ADC control pins will be floating, leaving the ADCs in an unknown state.

The PCI Target FW will be automatically uploaded to the EP1S10 from the EPC8 EEPROM, such that it is fully configured before the host BIOS interrogates its PCI Device Configuration Header. During boot-up, the host will interrogate the DPC device and allocate memory resources for DPC in the host memory map.

When the host has finished booting, a DPC device driver must be installed to facilitate DPC control and monitoring. This would normally be integrated into start-up scripts.

Application SW on the host can then interact with the DPC PCI Target's Configuration peripheral to configure the FPGA on the Slot#1 DDP. The desired (DSSS) configuration file, in Altera's tabular text file (.ttf) format, should reside on the host and be uploaded to the DDP.

The DSSS FW application is then available (FPGA user I/O are active, and the DSSS will respond as a peripheral on the back-end PCI-bus in accordance with its defined memory map) but unconfigured. Application SW should set the state of each configuration register to specify a desired operating mode.

The DSSS application expects a low IF or baseband quadrature input signal. This should be provided by a suitable wideband RF downconverter, tuned to the nominal carrier frequency and with its I/Q outputs connected to the I/Q inputs on the DCC via the DPC backpanel.

When it is desired to commence demodulation, the ADCs should be enabled with parallel interleaving and offset-binary data format. Keeping the ADCs disabled until this point reduces power dissipation.

AGC should be enabled at this stage. The AGC FW will provide a control word (an 8-bit digital attenuator setting) that needs to be monitored by the host and updated on the RF Downconverter on a periodic basis appropriate to the hosts scheduling priorities and the rate of change of amplitude variation induced by the channel.

Signal demodulation then requires the successful completion of a sequence of processes, starting with spreading code acquisition. Acquisition control registers should be set for the expected (or tested) signal conditions. Code tracking will take place when acquisition completes. The tracking loop gain may need to be (dynamically) adjusted to maintain acquisition. Symbol timing recovery will also be attempted when acquisition is completed. STR loop gain is normally static for a given symbol rate. The Receiver will produce a demodulated bitstream at this stage. The quality (BER) of the bitstream will depend on many factors, and it may be appropriate at this stage to initiate monitoring operations which attempt to verify valid demodulation, and initiate operations such as AFC to minimise BER.

The demodulated message bitstream is available via the DDP Digital I/O interface or may be logged directly by the host over PCI.

2. Receiver Interfaces

The Receiver I/O system is depicted in Figure 3. I/O can be classified as 'external', for signals which are connected to the DPC physical ports, or 'internal', for the subset of on-board slot-to-slot connections used by the DSSS application. The PCI interface is a key external interface, which has application-specific virtual interfaces in accordance with the DPC device memory map and DSSS FW.

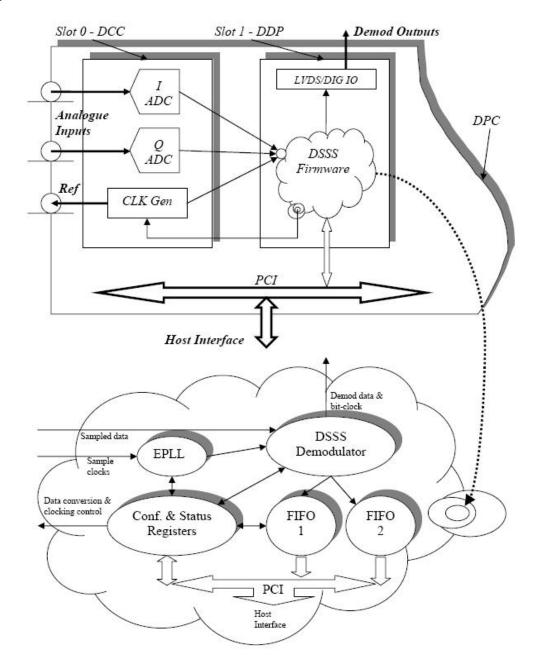


Figure 3- DPC and DSSS Interfaces

In a typical installation, the Receiver is powered, controlled and monitored via the PCI interface. The modulated input signal is applied to external analogue input channels, and the demodulated output bits are either taken as digital I/O from an external interface or logged over PCI to digital storage.

2.1 External Interfaces

2.1.1 Analogue Inputs

Designation : I_in, Q_in.

Location: DPC backpanel.

Type : SMA F/M.

Specifications: Maximum input: $-5V \le V_{in} \le +5V$

Full-scale input: $-128\text{mV} \le V_{\text{in}} \le +128\text{mV}$ Impedance: 50Ω , AC-coupled.

Signal BW: ≤ 100 MHz

Signal occupancy: 200 kHz \leq f_c \leq 300 MHz (768 MHz) {Narrowband}

Description: These are the primary signal inputs. Each input channel is independently but synchronously sampled with a 10-bit, 200MSPS ADC, leading to a maximum non-aliased signal BW of 100 MHz. When the signal spectrum extends beyond 100 MHz a complex downconversion is required to shift the spectrum below 100 MHz to avoid aliasing. The ADC BW is 768 MHz, but the realisable complex downconversion will be limited by the maximum internal LO that can be generated by DDS. For the given DSSS application this is presently 200 MHz, leading to the actual maximum occupancy of 300 MHz. For DSSS applications, I_in and Q_in should be used as a quadrature pair.

2.1.2 Reference Output

Designation: REF.

Location: DPC backpanel.

Type : SMA F/M.

Specifications : V_{OL} : $\leq 300 \text{mV} \{+3.2 \text{mA}\}$

 V_{OH} : $\geq 2.6V \{-3.2mA\}$ Impedance: 50Ω , DC-coupled. Frequency range: 10.7 MHz +/-180 kHz

Description: Provides a nominal 10.7 MHz squarewave reference signal for synchronisation of external systems. In DSSS applications where the input is at low-IF and final downconversion is done digitally this reference is likely to be redundant. Otherwise this reference may be used for AFC applications under control of the DSSS FW.

2.1.3 JTAG

Designation: JTAG.

Location: DPC backpanel.

Type : 12-pin, 0.1" header.

Specifications: JTAG standard port.

Description: This connector provides access to both a 3.3V and a 1.5V JTAG chain. The 3.3V chain accesses the DPC Mainboard FPGA and its configuration EEPROM. The 1.5V chain accesses FPGAs on Slots 0 to 3. Pin assignments for 3.3V or 1.5V connectivity follow from the DPC schematics Sheet "F1.3 BS-2". A breakout cable is available.

2.1.4 LVDS Digital I/O

Designation : DDP-X1.

Location : DDP component-side.

Type: 84-pin SAMTEC high speed header (2 x 42 x 0.8mm).

Specifications: $17m\Omega$, 2.0A per contact typical. 8GHz sinusoidal signalling rate.

Description: Operates as either 42 LVDS-standard differential I/O channels or 84 LVCMOS single-ended I/O channels. The DSSS FW configures the interface for 21 LVDS output channels and 21 LVDS input channels.

2.1.5 PCI Bus Connector

Designation : DPC-X1.

Location : DPC card edge.

Type: 64-bit universal PCI edge connector.

Specifications: See "PCI Local Bus Specification, Revision 2.2".

Description: The PCI physical interface supports 32/64-bit and 33/66 MHz transactions in accordance with Revision 2.2 of the PCI Standard. The DPC PCI Target FW supports the following transaction types from the standard:

C/BE[3::0]#	Command Type
0110	Memory Read
0111	Memory Write

1010	Configuration Read
1011	Configuration Write
1100	Memory Read Multiple
1110	Memory Read Line
1111	Memory Write and Invalidate

The DSSS FW operates in 32-bit/33 MHz mode and will halt transactions that request multiple data phases using 'Disconnect with data' handshaking (See Section 3.3.3.2 of the PCI 2.2 Standard).

2.2 Internal Interfaces

2.2.1 DCC Control Out

This is a set of logic signals passing from a Slot#1 DDP to a Slot#0 DCC for control of the ADCs and DDS. The signals include :

• ADC_SYNC: The ADC enable strobes, ACTIVE LOW, which enable both the sampled data ports and the output clock ports. A single signal is connected to both ADCs in parallel and should be controllable via the DDP (not tied low). The ADC_SYNC signal is sampled by the ADC Encode clock and must meet set-up and hold times with respect to the rising edge of this clock. However because the assertion of ADC_SYNC from the adjacent DDP will be asynchronous to the Encode clock it is possible for the signal to be asserted in violation of the set-up time, with the result that it is indeterminate if the ADC will synchronise sampling about the current clock edge or the next edge. This creates the possibility that the ADCs will synchronise about different edges, which will skew the relative timings of the sampled data in the I and Q channels.

To prevent this it is necessary to test the relative phases of the ADCs and repeatedly disable and enable the sampling until the correct phase is achieved. The DSSS FW provides a suitable test circuit based on sampling the output clock of one ADC with the output clock of the other ADC, and returning the sample result (1 or 0) via a status bit. For any given turn-on phase, the test result will be constant. In the alternate phase position, the opposite test result will be returned constantly. Thus if the skewed phase result is less likely than the correct result, the correct phase may be established by a majority vote on a set of tests.

- ADC_IP: Controls the relative timing (interleaved or parallel) of the demultiplexed A and B sampled data ports. The DSSS FW expects parallel mode (ADC_IP = 0).
- ADC_DFS: Controls the signed number format (offset binary or two's complement) of the sampled data. The DSSS FW expects offset binary (ADC_DFS = 0).
- dds_upd: Causes the DDS to update its output in accordance with the contents of its input registers (ACTIVE HIGH).
- dds_rst: Resets the DDS output to zero (ACTIVE HIGH).
- dds_clk: Clocks data in to the input registers, rising edge sensitive.
- dds_data[7..0] : Configuration data port for the DDS.

2.2.2 Sample Clock In

When the ADCs are enabled, each ADC outputs a demultiplexed sample rate clock (at 100 MHz) that is sample synchronous, i.e. the rising edge of the sample clocks is the optimum sampling point for the sampled data. A complement clock is also issued (falling edge sample synchronous). All four of these clocks strobes are routed from Slot#0 to Slot#1 for use by Slot#1 FW.

The DSSS FW utilises the true clock from the I-channel ADC as the reference clock (ref_clk) for DSSS signal processing. This clock becomes the reference to a Stratix EPLL entity that is programmed for both frequency and phase to become the DSSS chip clock (chip_clk).

The DSSS chip_clk may be programmed for periods of 20ns or more, in 10ns increments (giving allowable chip rates, in MHz or MCPS, of 50, 33.3, 25, 20, 16.6, 14.3, etc.). This is a limitation not of the EPLL but of the simplified sampled data decimation circuit which uses both ref_clk and chip_clk to decimate sampled data and only provides valid resampling when the 10ns increments are preserved.

The chip_clk phase may need to be adjusted when a new frequency is programmed or a new place and route of the DSSS FW is developed. This is because the sampled data from the ADCs has a narrow window of validity and the original synchronisation between sampled data and the ADC output clocks is skewed in an indeterminate way as the clocks and data are routed through the FPGA floorplan, or as the phase of the EPLL output clock changes when reprogrammed. Adjustment is a trial and error process based on visualising sampled data and checking for perturbations consistent with poor sampling phase. Once established for given operating conditions, the required phase is repeatable.

2.2.3 Sampled Data In

Sampled data is routed from Slot#0 to Slot#1. Each ADC outputs two (demultiplexed) streams of data, suffixed with A- or B- identifiers. Thus there are I_A[9..0], I_B[9..0], Q_A[9..0] and Q_B[9..0] data channels, each clocking at 100 MHz (a 4Gbps data throughput).

Note that the DSSS FW is an 8-bit application, and uses only the top 8-bits of each data channel.

2.2.4 Data and Clock Out

Demodulated data from the DSSS FW is available as a bitstream via the LVDS Digital I/O header on the DDP in Slot#1. To aid resampling of the bitstream a bit-synchronous clock is also provided (resample on the rising edge).

These signals are provided as single-ended LVCMOS (3.3V) digital outputs, with the demodulated data assigned to DDP-X1-p46 (EXT_TXOUT(16)) and the clock assigned to DDP-X1-p58 (EXT_TXOUT(20)). When used in conjunction with the DPC Break-out board these map to connectors X1-p9 and X2-p33 respectively.

2.2.5 Configuration and Status Register I/O

The DSSS FW implements a number of Configuration and Status Registers that facilitate control and monitoring of the DPC and the DSSS demodulator.

In the current configuration, there are 128 x 16-bit register locations of which 96 are designated as configuration registers (they may be written to by the PCI Host, and can be read by both the DSSS application and the host) and the remaining 32 are designated as status registers (they are written to by the DSSS application, and can only be read by the host). Register operations are synchronous with the PCI clock and hence asynchronous with the DSSS signal processing clocks (chip_clk and its derivatives).

Of these, forty four (44) configuration registers are in use, and are defined in Section 3. Fifteen (15) status registers are in use, and are defined in Section 4.

2.2.6 FIFO1 Out (Signal Monitoring)

The DSSS FW implements a 64k x 32-bit FIFO buffer for high rate sampling of the DSSS FW internal signals. The FIFO is clocked at half the chip rate (which is a legacy of an older generation of DSTO DSSS hardware). Thus the maximum sampling rate of internal signals is 25 MHz (at 50 MCPS). A variety of signal capture combinations are predefined in the FW (see <code>dsss_fifopacker.vhd</code> and <code>dsss_gbbm_port.vhd</code>). These are split into <code>modes</code> and <code>channels</code>, where the mode determines the actual sample rate of the signals (which may be increased by double-buffering when the signal of interest is no more than 16-bits in width, or decreased by interleaving multiple signals) and the channel determines which signals are input to that mode. This is discussed further in Section 5.

FIFO management is via the Configuration and Status registers. FIFO data is read over the PCI bus to the host. Note that although described as a FIFO this memory is in fact implemented with dual-port RAM internal to the EP1S80 FPGA on the DDP, and is allocated its full size in the DSSS memory map. Thus the PCI host can actually have random access to the FIFO if required. However the FIFO-like access granted to the DSSS application on the input side of the FIFO relies on internal address counters and control logic such that the FIFO, once filled, is only declared empty again after the host has performed 64k reads to FIFO memory space. Thus FIFO address pointers can become corrupted if the host accesses the memory this way.

2.2.7 FIFO2 Out (Data Logging)

The DSSS FW implements a dedicated data logging FIFO, with a dual, paged 8k x 32-bit arrangement. The incoming demodulated data bitstream is packed into 32-bit words and written into one FIFO (the write-FIFO) while the other FIFO (the read-FIFO) is being emptied by the host. When the write-FIFO fills it automatically becomes the read-FIFO and the previous read-FIFO, which should now have been emptied by the host, becomes the new write-FIFO. The Configuration and Status Register interface facilitates FIFO reset and FIFO

FULL and Overflow polling operations. A dedicated 32-bit register is assigned for FIFO2 retrieval, and the read-FIFO is emptied by 1 word every time this location is read by the host.

2.3 DSSS Memory Map

The DPC is allocated dedicated memory addresses in the host memory map. The size of the DPC memory allocation is determined by a constant specified in FW at boot time and read by the host BIOS from the DPC PCI Configuration Register space. This constant resides in the <code>pcitgt_package.vhd</code> file, where it is defined as follows:

```
-- PCI Base Address Register, Memory Space required: the L_CR_BAR_SIZE constant specifies the amount -- of memory space required, in units of 16 bytes. Determine the amount of memory required, write out -- the value in binary, subtract 1, and then invert to get the value to set the L_CR_BAR_SIZE constant. constant L_CR_BAR_SIZE : std_logic_vector(27 downto 0) := X"FFF0000";
```

This is the request used by the DSSS Receiver, and specifies a 16MB space. The actual ('physical' or 'bus') base address at which this memory resides is system dependent.

There are multiple PCI-capable peripherals within the DPC allocation (such as the FPGA Configuration entity, and the Slots #0 to #3) so additional partitioning of the DPC memory is required to enable decoding of individual 'chip-selects'. This partitioning is handled in the PCI Target FW. The following extract from *pciif_package.vhd* shows how the DPC memory is mapped in the DSSS Receiver application:

```
constant BKLC_XXX_LADDR
                              : std_logic_vector( 31 downto 0) := X"000000000";
-- Deliberately Unused Lower Address range.
constant BKLC_XXX_UADDR
                               : std_logic_vector( 31 downto 0) := X"000000FF";
-- Deliberately Unused Upper Address range.
constant BKLC_CFG_LADDR
                               : std_logic_vector( 31 downto 0) := X"00000100";
-- External Stratix Configuration Lower Address Range.
constant BKLC_CFG_UADDR
                               : std_logic_vector( 31 downto 0) := X"000001FF";
-- External Stratix Configuration Upper Address Range.
constant BKLC_PERIPH1_LADDR: std_logic_vector(31 downto 0) := X"00000200";
-- Example peripheral 1 Lower Address Range.
constant BKLC_PERIPH1_UADDR: std_logic_vector(31 downto 0) := X"000002FF";
-- Example peripheral 1 Upper Address Range.
constant BKLC_PERIPH2_LADDR: std_logic_vector(31 downto 0) := X"00000300";
-- Example peripheral 2 Lower Address Range.
constant BKLC_PERIPH2_UADDR: std_logic_vector(31 downto 0) := X"000003FF"
-- Example peripheral 2 Upper Address Range.
constant BKLC_IRQMGR_LADDR : std_logic_vector( 31 downto 0) := X"00000400";
-- Interrupt manager Lower Address Range.
constant BKLC_IRQMGR_UADDR : std_logic_vector( 31 downto 0) := X"000004FF";
-- Interrupt manager Upper Address Range.
constant BKLC_TP_LADDR
                             : std_logic_vector( 31 downto 0) := X"00000500";
-- Test Point Lower Address Range.
constant BKLC TP UADDR
                              : std_logic_vector( 31 downto 0) := X"000005FF";
-- Test Point Upper Address Range.
constant BKLC_TS_LADDR
                             : std_logic_vector( 31 downto 0) := X"00000600";
-- Temperature Sensor Lower Address Range.
```

```
constant BKLC_TS_UADDR
                             : std_logic_vector( 31 downto 0) := X"000006FF";
-- Temperature Sensor Upper Address Range.
constant BKLC_EXTSLOT0_LADDR: std_logic_vector(31 downto 0) := X"00000700";
-- External Slot 0 Lower Address Range.
constant BKLC_EXTSLOT0_UADDR: std_logic_vector(31 downto 0) := X"002006FF";
-- External Slot 0 Upper Address Range.
constant BKLC_EXTSLOT1_LADDR: std_logic_vector(31 downto 0) := X"00200700";
-- External Slot 1 Lower Address Range.
constant BKLC_EXTSLOT1_UADDR: std_logic_vector(31 downto 0) := X"004006FF";
-- External Slot 1 Upper Address Range.
constant BKLC EXTSLOT2 LADDR: std logic vector(31 downto 0) := X"00400700";
-- External Slot 2 Lower Address Range.
constant BKLC_EXTSLOT2_UADDR: std_logic_vector(31 downto 0) := X"006006FF";
-- External Slot 2 Upper Address Range.
constant BKLC_EXTSLOT3_LADDR: std_logic_vector(31 downto 0) := X"00600700";
-- External Slot 3 Lower Address Range.
constant BKLC_EXTSLOT3_UADDR: std_logic_vector(31 downto 0) := X"008006FF";
-- External Slot 3 Upper Address Range.
```

In the DSSS Receiver, Slot#1 hosts the DSSS FW and requires additional (local) chip-select generation to differentiate between its various targets, namely 16-bit registers, a 32-bit register, temperature sensor functions, and FIFO memory. This is handled in DSSS PCI target entities in accordance with the following address constants, extracted from <code>pbus_tgt_dsss.vhd</code> (and <code>dsss_tsif.vhd</code>):

```
constant TGT_BASE_ADDR : std_logic_vector(31 downto 0) := X"00200700"; constant MEM_SIZE : std_logic_vector(31 downto 0) := X"00010000"; constant REG_BASE_ADDR : std_logic_vector(31 downto 0) := X"00240700"; constant TSIF_BASE_ADDR : std_logic_vector(31 downto 0) := X"00250600"; constant BSIF_ADDR : std_logic_vector(31 downto 0) := X"002505FC"; (constant TSIF_BASE_ADDR : std_logic_vector(31 downto 0) := X"00094180";)
```

An equivalent data structure in the application software aids with memory-mapped accesses to the DPC, allowing simple offset addressing within named memory partitions. This structure is extracted from *dsssdriver.h*:

```
typedef struct
{
  unsigned long dsss_pci_spare[ 0x40];
  unsigned long dsss_pci_cnfg[ 0x40];
  unsigned long dsss_pci_plreg[ 0x40];
  unsigned long dsss_pci_plreg[ 0x40];
  unsigned long dsss_pci_irqmg[ 0x40];
  unsigned long dsss_pci_irqmg[ 0x40];
  unsigned long dsss_pci_testp[ 0x40];
  unsigned long dsss_pci_therm[ 0x40];
  unsigned long dsss_pci_slot0[ 0x640];
  unsigned long dsss_pci_slmem[ 0x10000];
  unsigned long dsss_pci_slreg[ 0x80];
  unsigned long dsss_pci_slspare[ 0x3F80];
  unsigned long dsss_pci_slot2[ 0x40];
  unsigned long dsss_pci_slot3[ 0x40];
} ddst_app_data;
```

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With this mapping, the first address of the 64k data capture FIFO is the first member of the dsss_pci_s1mem[] array, and Configuration and Status Register addresses defined in Sections 3 and 4 map 1:1 with offsets in the dsss_pci_s1reg[] array.

3. Configuration Register Definitions

Configuration registers specify the mode of operation of the DSSS FW. There are 44×16 -bit registers, referenced by their firmware signal name and listed in order of increasing address offset within the DSSS memory map. The memory mapping of registers is defined in the VHDL file $dsss_gbbm_port.vhd$.

3.1 fir_bypass

Nam	ie:	FIR F	ilter B	ypass											
Determines whether sampled data is filtered by the FW LP fil provide band-limiting and act as chip-matched filters when the signal is appropriately pulse-shaped. If not filtered (filters by sampled data is unaffected. Note that filtering introduces a fround of the sampled and unfiltered modes apparent magnitude of the received signal. Desc: Also provides an additional control associated with the FIFO interface (Sections 2.2.6 and 5). Establishes whether the signal sampled data capture channels are either I and Q with full bit case either I or Q can be sampled at full rate, but not both at control with half bit width (in which case both I and Q can be sampled simultaneously, as is required for valid spectrum analysis).										en the s bypas a fraction of the second seco	e trans assed) etiona an var Signal fed in vidth ce) or	then I gain ry the I Monuto the (in wl	K =		
	Addı	ress:			0x0	00		No	minal	Valu	e:		0x0	000	
			·				Bit M	1ар							
B15	B14	B13	B12	B11	B10	В9	B8	B7	В6	В5	B4	В3	B2	B1	ВО
Х	Х	Х	X	Х	Х	Х	Х	Х	Х	Х	Х	SM	BY		

 $X \rightarrow Don't$ care.

BY \leftrightarrow FIR filter bypass (ACTIVE HIGH). When asserted, the filters are bypassed, otherwise the filters are in-line.

 $SM \leftrightarrow Spectrum$ Analyser Mode (ACTIVE HIGH). When asserted, data channels input to the FIFO1 Signal Monitor interface are available which represent both the I and Q A- and B-phase samples at full sample rate (i.e. 2 samples per chip). This facilitates spectrum analysis.

3.2 reset ctrl

Nam	Name: Reset control																
Desc	Desc: Provides reset/enable control signals to multiple components and entities.																
	Address: 0x01									Nominal Value:				0x1000 (Reset) 0x2BFF (Run)			
							Bit N	1ар									
B15 B14 B13 B12 B11 B10 B9 B8 B7 B6 B5 B4 B3 B2 B1 B												В0					
Х	Χ	R13	R12	R11	Χ	R9	R8	R7	R6	R5	R4	R3	R2	R1	R0		

 $X \rightarrow Don't$ care.

 $R0 \leftrightarrow$ Interpolator reset (ACTIVE LOW). When asserted, holds all interpolator registers (including outputs) LOW.

 $R1 \leftrightarrow AGC$ reset (ACTIVE LOW). When asserted, holds the AGC value static and resets the AGC loop timer (but does not affect the AGC value in BITE mode).

R2 ↔ Acquisition Control reset (ACTIVE LOW). Resets the chip acquisition control logic and returns the dwell state to the unacquired state (at the bottom of the dwell tree). Acquisition cannot be achieved while this signal is asserted.

 $R3 \leftrightarrow ELDLL$ reset (ACTIVE LOW). Resets the early-late gate delay-locked loop chip tracking circuit. Drives the interpolator to state-2.

R4 ↔ PN reset (ACTIVE LOW). Preloads the PRBS generators with state vectors specified in the PRBS control registers (Initial Value registers) and halts PRBS generation.

 $R5 \leftrightarrow DSSS$ Despreader reset (ACTIVE LOW). Holds the despreader circuit inactive and zeroes despreader outputs.

 $R6 \leftrightarrow Differential\ Detector\ reset\ (ACTIVE\ LOW)$. Resets the differential detector outputs (magnitude and angle) to zero.

R7 ↔ Symbol Decoder reset (ACTIVE LOW). Halts symbol decoding, output bitstream is held static.

 $R8 \leftrightarrow AFC$ enable (ACTIVE HIGH). Allows AFC firmware to update the digital downconverter at a programmed rate (Section 3.34).

 $R9 \leftrightarrow Symbol Timing Recovery enable (ACTIVE HIGH)$. Enables the STR loop. If disabled there will be no reference clock for the despreader and all subsequent circuits.

R11 ↔ FIR Filter reset (ACTIVE LOW). Resets the FIR filters, with outputs tied to zero. When fir_bypass is asserted sampled data is not affected.

R12 ↔ ADC enable (ACTIVE LOW). When deasserted the I and Q channel ADCs are idle (sampled data outputs constant, sample clocks static). When asserted the ADCs commence sampling at full rate and the sample clocks are available to the DSSS FW.

 $R13 \leftrightarrow Acquisition Hold-up$ enable (ACTIVE HIGH). Turns on the acquisition hold-up circuit, which provides robustness to acquisition decisions in the presence of score nulling introduced by the underlying data. Deassertion is effectively a bypass mode, so that acquisition is still possible. Note that the hold-up circuit has a latency of 1 clock cycle, so the PRBS offset phases (Sections 3.24 and 3.27) must be adjusted accordingly.

3.3 interp_ctrl

Nam	Name: Interpolator control														
Desc	Selects automatic or manual control of the interpolators. Automatic control is provided by the ELDLL chip tracking loop. Manual control is provided for BITE only.														
Address: 0x02 Nominal Value: 0x0000											al Value: 0x0000				
							Bit N	Лар							
B15 B14 B13 B12 B11 B10 B9 B8 B7 B6 B5 B4 B3 B2 B1											В0				
Х	Х	Х	X	X	X	Χ	Х	Х	Х	Х	Х	Isel	I2	I1	10

 $X \rightarrow Don't$ care.

I[2..0] \leftrightarrow Interpolator state number when in MANUAL/BITE mode. States 0 to 3 are valid. States 4 to 7 are reserved for future use and will only map back to states 0 to 3 (I2 masked to 0).

Isel ↔ Interpolator mode select. LOW selects automatic, HIGH selects manual.

3.4 agc_dwell

Nam	Name: AGC dwell value.														
Desc: Specifies the number of (chip) clocks over which each test (dwell) in the AGO loop is conducted. In each dwell period, the number of ADC overflow event is accumulated, starting from zero.															
	Addı	ess:			Nominal Value :				0x4E20						
			_]	Bit M	ap							
B15 B14 B13 B12 B11 B10 B9 B8 B7 B6 B5 B4 B3 B2 B1 B0											В0				
D15	D14	D13	D12	D11	D10	D9	D8	D7	D6	D5	D4	D3	D2	D1	D0

 $D[15..0] \leftrightarrow AGC$ dwell value in the range 0 to 65535 clock edges.

3.5 agc_thresh

Nam	ne: AGC threshold value.														
Desc	Desc: Specifies the number of ADC overflow events per AGC dwell period that the AGC should maintain.														
Address: 0x04 Nominal Value: 0x07D0															
]	Bit M	ар							
B15 B14 B13 B12 B11 B10 B9 B8 B7 B6 B5 B4 B3 B2 B1 B0											В0				
D15	D14	D13	D12	D11	D10	D9	D8	D7	D6	D5	D4	D3	D2	D1	D0

D[15..0] \leftrightarrow AGC threshold value in the range 0 to 65535 full-scale (FS) events. Note that on any sample clock edge there may be 0, 1 or 2 FS events depending on whether either the I or Q channel A-phase samples overflowed, either the I or Q channel B-phase samples overflowed, or both an A-phase and a B-phase sample overflowed.

3.6 agc_gain

Nam	ne:	AGC loop gain value. Loop gain affects AGC convergence time and steady-state jitter (in a HW-only loop – only steady-state jitter will be affected in a SW-updated loop). The loop gain is implemented as a bit-slicing operation and the loop gain value has a 1:1 correspondence to the number of right-shifts of scaling applied to the loop														
Desc	2:	loop gain corre	- only is imp spond	stead lemen	y-state ted as to the	e jitter a bit- numb	will will slicing	be affe g oper right-s	ected i ration shifts o	in a Si and t of scal	N-uphe location	dated op gair pplied	loop). 1 valu	. The l ie has	oop a 1:1	
	Addı	ress:			minal	l Valu	e:		0x0	0003						
							Bit N	Лар								
B15	B14	B13	B12	B11	B10	В9	B8	B7	В6	B5	B4	В3	B2	B1	В0	
Х	х	Х	Х	х	Х	Χ	Х	Х	Χ	Х	Х	х	K2	K1	K0	

 $X \rightarrow Don't$ care.

 $K[2..0] \leftrightarrow AGC$ loop gain value in the range 0 to 7.

3.7 agc_ctrl

Nam	.e :	AGC	contr	ol.											
Desc	:						contro Manua								
	Address: 0x06 Nominal Value: 0x0000														
	Bit Map														
B15															
X	Х	Х	Χ	х	Χ	Χ	Asel	D7	D6	D5	D4	D3	D2	D1	D0

 $X \rightarrow Don't$ care.

 $\mbox{Asel} \leftrightarrow \mbox{AGC mode select. LOW selects automatic attenuator control, HIGH selects manual control.}$

 $D[7..0] \leftrightarrow AGC$ output (for direct setting of downconverter digital attenuators).

3.8 acq_thresh0

Nam	ie:	Acqu	isitior	n thres	hold ().									
Desc	:			esholo clare <i>a</i>											in
	Address: 0x07 Nominal Value: 0x0032														
	Bit Map														
B15	B14	B13	B12	B11	B10	В9	B8	B7	В6	B5	B4	В3	B2	B1	ВО
T15	T14	T13	T12	T11	T10	Т9	Т8	T7	Т6	Т5	T4	Т3	T2	T1	ТО

 $T[15..0] \leftrightarrow$ Threshold value. This value is scaled by a factor of 64 by internal FW.

3.9 acq_thresh1

Nam	ie:	Acqu	isitior	n thres	hold 1										
Desc	! :			esholo clare a					-	-					in
	Address: 0x08 Nominal Value: 0x0019														
							Bit N	Лар							
B15															
T15	T14	T13	T12	T11	T10	Т9	Т8	T7	Т6	Т5	T4	Т3	T2	T1	ТО

 $T[15..0] \leftrightarrow$ Threshold value. This value is scaled by a factor of 64 by internal FW.

3.10 acq_thresh2

Name:	Acquisition threshold 2.
Desc:	Sets the threshold that must be exceeded by the acquisition correlation test in order to declare acquisition when in State '2' of the acquisition dwell tree.

	Addı	ress:			0x0	9		No	minal	Valu	e:		0x0	019	
Bit Map															
B15	B14	B13	B12	B11	B10	В9	B8	B7	В6	В5	B4	В3	B2	B1	В0
T15	T14	T13	T12	T11	T10	Т9	Т8	T7	Т6	T5	T4	Т3	T2	T1	ТО

 $T[15..0] \leftrightarrow$ Threshold value. This value is scaled by a factor of 64 by internal FW.

3.11 acq_thresh3

Nam	ie:	Acqu	isition	n thres	hold 3	3.									
Desc	! :			esholo clare a					-	-					in
	Address: 0x0A Nominal Value: 0x0019														
	Bit Map														
B15															
T15	T14	T13	T12	T11	T10	Т9	Т8	T7	Т6	Т5	T4	Т3	T2	T1	ТО

 $T[15..0] \leftrightarrow$ Threshold value. This value is scaled by a factor of 64 by internal FW.

3.12 acq_thresh4

Nam	ie:	Acqu	isitior	thres	hold 4										
Desc	::								-	-		on cor			in
Address: 0x0B Nominal Value: 0x0019															
							Bit N	Лар							
B15	B14	B13	B12	B11	B10	В9	B8	B7	В6	B5	B4	В3	B2	B1	В0

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 $T[15..0] \leftrightarrow$ Threshold value. This value is scaled by a factor of 64 by internal FW.

3.13 acq_thresh5

Nam	ie:	Acqu	isitior	thres	hold 5	5.									
Desc	2:			esholo clare a					-	-					in
	Address: 0x0C Nominal Value: 0x0019														
	Bit Map														
B15															
T15	T14	T13	T12	T11	T10	Т9	Т8	T7	Т6	Т5	T4	Т3	T2	T1	ТО

 $T[15..0] \leftrightarrow$ Threshold value. This value is scaled by a factor of 64 by internal FW.

3.14 acq_thresh6

Nam	ie:	Acqu	isitior	n thres	hold 6	Ď.									
Desc	:			esholo clare a					-						in
	Address: 0x0D Nominal Value: 0x0019														
							Bit N	Лар							
B15															
T15	T14	T13	T12	T11	T10	Т9	Т8	T7	Т6	T5	T4	Т3	T2	T1	T0

 $T[15..0] \leftrightarrow$ Threshold value. This value is scaled by a factor of 64 by internal FW.

3.15 acq_thresh7

Nam	ie:	Acqu	isitior	thres	hold 7	⁷ .									
Desc	!:			esholo clare a					-						t in
	Address: 0x0E Nominal Value: 0x0019														
							Bit N	Лар							
B15	B14	B13	B12	B11	B10	В9	B8	B7	В6	B5	B4	В3	B2	B1	В0
T15	T14	T13	T12	T11	T10	Т9	Т8	T7	Т6	Т5	T4	Т3	T2	T1	ТО

 $T[15..0] \leftrightarrow$ Threshold value. This value is scaled by a factor of 64 by internal FW.

3.16 acq_serdwell

Name:		Serial acquisition dwell.													
Desc: Sets the dwell (in chip clocks) for each test in a serial mode of acquisition						ition.									
	Addı	ress:		0x0F				Nominal Value :				0x0000			
Bit Map															
B15	B14	B13	B12	B11	B10	В9	В8	B7	В6	B5	B4	В3	B2	B1	В0
Х	Х	Х	Χ	Х	Χ	Χ	D8	D7	D6	D5	D4	D3	D2	D1	D0

 $X \rightarrow Don't$ care.

 $D[8..0] \leftrightarrow D$ well value in the range 0 to 511.

3.17 acq_ctrl

Name:	Acquisition control.			
Desc:	Sets the acquisition correlation mode and dwell tree depth.			

	Addı	ess:			0x1	0		No	minal	Valu	e :		0x0	010	
Bit Map															
B15	B14	B13	B12	B11	B10	В9	B8	B7	В6	B5	B4	В3	B2	B1	В0
Х	Х	Х	Х	Х	Х	Χ	Х	Х	S_P	D2	D1	D0	M2	M1	M0

 $X \rightarrow Don't$ care.

S_P \leftrightarrow Serial (HIGH) or parallel (LOW) correlation mode. ONLY PARALLEL MODE SHOULD BE USED. SERIAL MODE IS RESERVED FOR FUTURE USE.

 $D[2..0] \leftrightarrow D$ well tree depth, in the range 1 to 7. DO NOT SET TO ZERO.

 $M[2..0] \leftrightarrow$ Correlation mode. Refer to the table below. When setting acquisition thresholds with respect to the output scores, note that the output is derived from a sum of squares of values, and has a quadratic rather than a linear profile.

M[20]	Correlation Type	Processing	Output range
		Gain	
000	QPSK, 1-bit x 512 chips	27dB	0262,144
001	QPSK, 2-bit x 256 chips	24dB	0589,824
010	QPSK, 4-bit x 128 chips	21dB	03,686,400
011	BPSK, 1-bit x 1024 chips	30dB	0262,144
1XX	BPSK, 4-bit x 256 chips	24dB	03,686,400

3.18 chips_per_sym

Nam	e :	Chip	s per s	ymbol											
Desc	:			symbo period		with	respe	ct to t	he chi	p rate	e, as tl	he nui	mber	of chi	ps
	Addı	ess:	r symbol period. : 0x11 Nominal Value : F _{chip} / F _{sym}												
]	Bit M	ар							
B15	B14	B13	B12	B11	B10	В9	B8	B7	В6	B5	B4	В3	B2	B1	В0
D15	D14	D13	D12	D11	D10	D9	D8	D7	D6	D5	D4	D3	D2	D1	D0

D[15..0] \leftrightarrow Number of chips per symbol, calculated as the chip clock frequency divided by the symbol rate (both in Hz). The range 25 to 10000 is valid (other values may cause unexpected results)

3.19 acqh_Nsym

Nam	e:	Acqu	isitior	n hold-	up sy	mbol	count	-								
Desc	! :	the A	.CQD have 1	ating properties of the correct of t	sserted ed a fa	d, eve il stat	n thou us. Th	ıgh so nis allo	ome ac ows fa	quisit il eve	ion te	ests in	that g	gate pe	eriod	
	Addı	ress:	nulling of the correlation score to be neglected. ss: 0x12 Nominal Value: 0x64													
							Bit N	Лар								
B15	B14	B13	B12	B11	B10	В9	B8	B7	В6	B5	B4	В3	B2	B1	ВО	
Х	Х	Х	X	Х	X	Х	Х	D7	D6	D5	D4	D3	D2	D1	D0	

 $X \rightarrow Don't$ care.

 $D[7..0] \leftrightarrow \text{Number of symbols in the gate or 'hold-up' window.}$

3.20 dll_gain

Nam	ie:	Track	king lo	op ga	in.										
Desc	:	Sets t		DLL lo	oop ga	in. Tł	ne ove	erall lo	op ga	in is I	(_{dll} =]	M x 2 ⁻¹	E (but	see	
	Address: 0x13 Nominal Value: (Variable)														
							Bit N	Лар							
B15	B14	B13	B12	B11	B10	В9	В8	B7	В6	B5	B4	В3	B2	B1	В0
Х	Х	Х	Χ	Х	X	Χ	Χ	ЕЗ	E2	E1	E0	M3	M2	M1	M0

 $X \rightarrow Don't$ care.

 $M[3..0] \leftrightarrow Mantissa$. An integer scale factor in the range 0 to 15.

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 $E[3..0] \leftrightarrow Exponent$. A bit shift in the range 0 to 2^{-15} . Note that a zero value results in NO SHIFT.

The desired value may be determined either by a trained operator (based on jitter in an interpolator state vector plot window) or through an automation algorithm (see Section 6.2.2).

3.21 dll_dwell

Nam	ie:	Track	king lo	op dw	vell.										
Desc	2:			DLL lo	-		_			_	•		e the p	proces	sing
	gain) for both the advanced and retarded correlation tests. Address: 0x14 Nominal Value: (Variable)														
							Bit N	Лар							
B15	B14	B13	B12	B11	B10	В9	B8	B7	В6	B5	B4	В3	B2	B1	ВО
Х	Х	Х	Х	х	Χ	Х	D8	D7	D6	D5	D4	D3	D2	D1	D0

$X \rightarrow Don't$ care.

 $D[8..0] \leftrightarrow ELDLL$ loop dwell in the range 0 to 511 chips. This should be set high enough for sufficient processing gain but low enough (fast enough) to allow the actual chip clock error to be compensated. A typical set point is ½-symbol duration.

3.22 iprbs_tap

Nam	e :	I-cha	nnel P	RBS ta	ıp wor	d.									
Desc	:	Defir	es the	PRBS	seque	nce fo	r the	I-char	nnel s _l	pread	ing co	ode.			
	Address: 0x15 Nominal Value: (Variable)														
]	Bit M	ар							
B15	B14	B13	B12	B11	B10	В9	В8	B7	В6	B5	B4	В3	B2	B1	В0
D15	D14	D13	D12	D11	D10	D9	D8	D7	D6	D5	D4	D3	D2	D1	D0

 $D[15..0] \leftrightarrow$ Tap settings for a linear feedback shift register (LFSR) PRBS generator. PRBSs of length 3 to 65535 chips may be generated. Bits D[15..0] map to G[16..1], where G[i] is the ith coefficient in the generator polynomial for the sequence.

3.23 iprbs_pha

Nam	e :	I-cha	nnel P	RBS ir	nitial p	hase.									
Desc	:	Defir	nes the	reset/	'preloa	nd sta	te of t	he I-c	hanne	el PRE	SS.				
	Address: 0x16 Nominal Value: (Variable)														
			·]	Bit M	ар							
B15	B14	B13	B12	B11	B10	В9	B8	B7	В6	B5	B4	В3	B2	B1	В0
D15	D14	D13	D12	D11	D10	D9	D8	D7	D6	D5	D4	D3	D2	D1	D0

 $D[15..0] \leftrightarrow$ Initial state of the PRBS generator when reset (preloaded).

THIS MUST NOT BE THE ALL-ZEROES STATE.

THIS SHOULD BE DIFFERENT TO THE qprbs_pha IF THE I AND Q CHANNEL CODES HAVE THE SAME TAP WORD.

3.24 iprbs_ospha

Nam	e :	I-cha	nnel P	RBS of	fset pl	nase.									
Desc	:	the I times	PRBS [.] s equal	advand would to the omper	reach latenc	from cy in t	its in	itial st quisit	tate if ion ci	it had	l been	clock	ed a 1	numb	er of
	Addı	system to compensate for pipeline latencies. ddress: 0x17 Nominal Value: F(iprbs_pha)													
]	Bit M	ар							
B15	B14	B13	B12	B11	B10	В9	B8	B7	В6	B5	B4	В3	B2	B1	В0
D15	D14	D13	D12	D11	D10	D9	D8	D7	D6	D5	D4	D3	D2	D1	D0

 $D[15..0] \leftrightarrow$ Computed advanced generator state based on the initial phase word specified in the iprbs_pha register and the known latency (in chip clocks) of the acquisition system.

3.25 qprbs_tap

Nam	e :	Q-ch	annel I	PRBS t	ap wo	rd.									
Desc	:	Defir	nes the	PRBS	seque	nce fo	r the	Q-cha	nnels	spread	ding o	code.			
	Address: 0x18 Nominal Value: (Variable)														
			·]	Bit M	ар							
B15	B14	B13	B12	B11	B10	В9	B8	B7	В6	B5	B4	В3	B2	B1	В0
D15	D14	D13	D12	D11	D10	D9	D8	D7	D6	D5	D4	D3	D2	D1	D0

 $D[15..0] \leftrightarrow$ Tap settings for a linear feedback shift register (LFSR) PRBS generator. PRBSs of length 3 to 65535 chips may be generated. Bits D[15..0] map to G[16..1], where G[i] is the ith coefficient in the generator polynomial for the sequence.

3.26 qprbs_pha

Nam	e :	Q-ch	annel]	PRBS i	nitial լ	phase	•								
Desc	:	Defir	nes the	reset/	'preloa	ad sta	te of t	he Q-	chanr	el PR	BS.				
	Address: 0x19 Nominal Value: (Variable)														
]	Bit M	ap							
B15	B14	B13	B12	B11	B10	В9	B8	B7	В6	B5	B4	В3	B2	B1	В0
D15	D14	D13	D12	D11	D10	D9	D8	D7	D6	D5	D4	D3	D2	D1	D0

 $D[15..0] \leftrightarrow Initial state of the PRBS generator when reset (preloaded).$

THIS MUST NOT BE THE ALL-ZEROES STATE.

THIS SHOULD BE DIFFERENT TO THE iprbs_pha IF THE I AND Q CHANNEL CODES HAVE THE SAME TAP WORD.

3.27 qprbs_ospha

Nam	e :	Q-ch	annel]	PRBS o	offset p	hase.									
Desc	:	the Ç of tin	PRBS	advan would ual to t systen	d reacl the late	n fron ency i	n its ii n the	nitial s acqui	state i sition	f it ha circui	d bee it. Thi	n cloc	ked a	numl	
	Addı	ess:	quisition system to compensate for pipeline latencies. : 0x1A Nominal Value : F(qprbs_pha)												
]	Bit M	ар							
B15	B14	B13	B12	B11	B10	В9	B8	B7	В6	B5	B4	В3	B2	B1	В0
D15	D14	D13	D12	D11	D10	D9	D8	D7	D6	D5	D4	D3	D2	D1	D0

 $D[15..0] \leftrightarrow$ Computed advanced generator state based on the initial phase word specified in the qprbs_pha register and the known latency (in chip clocks) of the acquisition system.

3.28 mode/dds_ctrl

Nam	ie:	Mod	e and	DDS c	ontrol									
Desc	Various control bits relating to BITE and REF OUT DDS control.													
	Address: 0x1B Nominal Value: 0x0020													
							Bit 1	Мар						
B15	15 B14 B13 B12 B11 B10 B9 B8 B7 B6 B5 B4 B3 B2 B1 B0													
Х	Х	Х	X X X X X Drst 1 Dup M3 X M2 M1											

 $X \rightarrow Don't$ care.

 $Drst \leftrightarrow DDS$ Reset (ACTIVE HIGH). Resets the DDS on the adjacent DCC module. This DDS generates the REF output signal (Section 2.1.2).

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Dup ↔ DDS Update. A rising edge on this bit causes the DDS to be reprogrammed with the current contents of its internal update registers.

M3 ↔ Enable PRBS loop back test. When this bit is HIGH an unmodulated, fixed-scale copy of the spreading codes is muxed in to the front end of the DSSS receiver instead of actual sampled data. This provides a rudimentary built-in-test capability.

M2 ↔ Force the ACQD flag. When this bit is HIGH the ACQD flag is driven high (asserted) even though acquisition may not have been achieved. This enables rudimentary built-in-test of functions that are only enabled when the ACQD flag is asserted.

 $M1 \leftrightarrow BPSK$ mode. When this bit is HIGH the DSSS despreader circuits are in BPSK mode. This is reserved for future use, and should generally be left LOW.

3.29 str_dwell

Nam	e :	Syml	ool tim	ing re	covery	loop	dwe	11.							
Desc	Desc: Sets the number of chips per symbol for the STR loop.														
	Address: 0x1C Nominal Value: chips_per_sym-3														
	Bit Map														
B15	5 B14 B13 B12 B11 B10 B9 B8 B7 B6 B5 B4 B3 B2 B1 B0														
D15	D14	D13	D12 D11 D10 D9 D8 D7 D6 D5 D4 D3 D2 D1 D0												

 $D[15..0] \leftrightarrow$ (Number of chips per symbol) - 3. The offset of 3 here compensates for a 3-chip latency in the STR loop.

3.30 str_gain

Name:	Symbol tin	ning recovery loop gair	n and DDS Byte0						
Desc :		R loop gain. The overage one byte of the REF D	Il loop gain is $K_{str} = M x$ DS configuration data.	2 ^{-E} (but see below).					
Address: 0x1D Nominal Value: 0x00K _e K _m									
Bit Map									

B15	B14	B13	B12	B11	B10	В9	B8	B7	В6	B5	B4	В3	B2	B1	В0
D7	D6	D5	D4	D3	D2	D1	D0	ЕЗ	E2	E1	E0	МЗ	M2	M1	M0

 $M[3..0] \leftrightarrow Mantissa$. An integer scale factor in the range 0 to 15.

 $E[3..0] \leftrightarrow Exponent$. A bit shift in the range 0 to 2^{-15} . Note that a zero value results in NO SHIFT.

The desired value follows from known receiver operating characteristics and the symbol rate: $K_{str} = R_{sym}*(26e-9) + 0.017$ (R_{sym} in symbols per second). Note that K_{str} is quantised – the nearest possible value should be chosen.

 $D[7..0] \leftrightarrow Byte0$ of the five byte DDS configuration register. This should be set to all zeroes.

3.31 str_lock

Nam	e:	Syml	ool tim	ing re	covery	loop	lock	thres	hold.						
Desc	is still deemed to be locked.														
Address: 0x1E Nominal Value: 10% of chips_per_sym											m				
	Bit Map														
B15	B15 B14 B13 B12 B11 B10 B9 B8 B7 B6 B5 B4 B3 B2 B1 B0														
D15	D14	D13	D12	D11	D11 D10 D9 D8 D7 D6 D5 D4 D3 D2 D1 D0										

 $D[15..0] \leftrightarrow Lock$ margin, 16-bit unsigned. If the deviation in symbol sample instant on successive symbols is less than this value, and the acquisition state is 'acquired', then the STR LOCK flag will be asserted.

3.32 dds_msw

Name:	DDS frequency – most significant word.
Desc:	The DDS output frequency for the DCC REF output is set by a 32-bit word. This register is the MSW of that word.

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	Address: 0x1F							No	minal	l Valu	e:	0x1B63			
	Bit Map														
B15	B15 B14 B13 B12 B11 B10 B9 B8 B7 B6 B5 B4 B3 B2 B1 B0														
F31 F30 F29 F28 F27 F26 F25 F24 F23 F22 F21 F20 F19 F18 F17 F3										F16					

 $F[31..16] \leftrightarrow Bytes~1~and~2~of~the~five~byte~DDS~configuration~registers.$ These represent the upper 16-bits of the 32-bit frequency control word.

$3.33 dds_lsw$

Nam	ie:	DDS	frequ	ency –	least	signif	icant v	word.							
Desc	:		The DDS output frequency for the DCC REF output is set by a 32-bit word. This register is the LSW of that word.												
	Address: 0x20 Nominal Value: 0x8906														
	Bit Map														
B15	15 B14 B13 B12 B11 B10 B9 B8 B7 B6 B5 B4 B3 B2 B1 B0														
F15	F14	F13	F12 F11 F10 F9 F8 F7 F6 F5 F4 F3 F2 F1 F0												

 $F[15..0] \leftrightarrow$ Bytes 3 and 4 of the five byte DDS configuration registers. These represent the lower 16-bits of the 32-bit frequency control word.

3.34 afc_rate

Name:	AFC upda	te rate.		
Desc :	AFC loop to estimate at	er of symbols between for runs continuously when every symbol clock ever does not need to be this	n enabled, producing a fent. However the rate of	frequency error f application of the
Add	ress:	0x21	0x0800	

]	Bit M	ар							
B15	15 B14 B13 B12 B11 B10 B9 B8 B7 B6 B5 B4 B3 B2 B1 B0														
D15	D14	D13	D12	D11	D10	D9	D8	D7	D6	D5	D4	D3	D2	D1	D0

 $D[15..0] \leftrightarrow Number of symbols between updates to the downconversion frequency in accordance with the current AFC loop frequency error estimate.$

3.35 ddet_gain

Nam	ie:	Diffe	rentia	l detec	ctor bi	t-slice	r 'gaiı	n'.							
Desc	::	magi magi conse	nitude nitude erve F ion of	ential of term has a W reso the LS	is the 16-bit ources	result repre , the 3	ant of esenta 31-bit	Y _n tion, le term i	* Y _{n-1} eadinş s trun	for i g to a ; cated	nput s 31-bit to a 1	symbo outpu 6-bit t	ols Y _k . 1t tern erm, v	The in n. To with th	ne
	Addı	ess:		0x22 Nominal Value : 0x0009											
	Bit Map														
B15 B14 B13 B12 B11 B10 B9 B8 B7 B6 B5 B4 B3 B2 B1 E										В0					
Х	Х	Х	X X X X X X X X D3 D2 D1 D0												

$X \rightarrow Don't$ care.

 $D[3..0] \leftrightarrow Bit$ position for the LSB of the 16-bit slice of a 32-bit magnitude term, in the range 0 to 15. Note that if the gain is incorrectly set (i.e. set such that the chosen bit slice overflows, or such that there are significant bits above the chosen slice) then the interpretation of the differentially detected magnitude will be invalid when monitored. However this will have no effect on BER, as only the angle term is significant in the demodulation process.

3.36 clkset_data

Name:	Clock set data parameters.
-------	----------------------------

Desc	::	clock EPLI	used L (enha	througanced	ghout PLL) e	the D entity	SSS I in th	W. R e FPC	etimin SA. Th	g is ac is reg	oduce to chieved ister su f the El	d with applie	an ei	nbedo	ded
	Address: 0x24								omina	l Valu	1e:		0x4	800	
							Bit I	Map							
B15	B14	B13	B12	B11	B10	В9	В8	B7	В6	В5	B4	В3	B2	B1	В0
F2	F1	F0	I3	I2	I1	10	D8	D7	D6	D5	D4	D3	D2	D1	D0

I[3..0] \leftrightarrow Identity code. Identifies which counter in the EPLL is to be updated (see Altera Application Note AN282, Table 6).

 $F[2..0] \leftrightarrow$ Feature code. Identifies which parameter of the selected counter is to be updated (see Altera Application Note AN282, Table 7).

 $D[8..0] \leftrightarrow Data$. The new value for the selected counter feature.

3.37 clkset_ctrl

Nam	ie:	Clocl	k set c	ontrol	paran	neters	5.								
Desc	::	The DCC output clock is retimed in the DDP to produce the master chip-rate clock used throughout the DSSS FW. Retiming is achieved with an embedded EPLL (enhanced PLL) entity in the FPGA. This register controls update commands for run-time configuration of the EPLL. Tess: Ox25 Nominal Value: Ox0000													
	Addı	ress:			0x2	5		No	omina	l Valı	1e:		0x0	0000	
							Bit 1	Map							
B15	B14	B13	B12	B11	B10	В9	B8	B7	В6	В5	B4	В3	B2	B1	В0
Х	Х	Х	Х	Х	Х	Х	Х	Х	Х	Х	Х	Х	Clr	Upd	Wr

 $X \rightarrow Don't$ care.

Clr ↔ Asynchronous reset (ACTIVE HIGH). Resets the EPLL configuration entity.

 $Upd \leftrightarrow Update$ (ACTIVE HIGH). Loads the EPLL with the configuration data stored in a configuration register cache.

 $Wr \leftrightarrow Write$ (ACTIVE HIGH). Updates the selected field in the configuration register cache.

3.38 fifo_ctrl

Nam	e:	FIFO	contr	ol para	amete	rs.									
Desc	! :				•					-	e of sel pture o			chann	els
	Address: 0x26							N	omina	l Valı	1e:		0x0	00F	
							Bit 1	Мар							
B15	B14	B13	B12	B11	B10	В9	В8	B7	В6	В5	B4	В3	B2	B1	В0
X	Х	Х	Х	Х	Х	Х	Х	Х	Х	En	МЗ	M2	M1	M0	Clr

 $X \rightarrow Don't$ care.

 $En \leftrightarrow Asynchronous$ enable (ACTIVE HIGH). Initiates data capture with the selected channel.

 $M[3..0] \leftrightarrow$ Capture Mode. Selects one of 16 data capture modes (see Section 5).

 $Clr \leftrightarrow Asynchronous clear (ACTIVE HIGH)$. Clears the data capture FIFO.

3.39 acqh_symlen

Nam	e :	Acqu	isitior	hold-	up syr	nbol 1	lengtl	1.							
Desc	:	Sets t	he nu	mber o	of chips	s per	symb	ol for	the ac	equisi	tion h	old-up	circu	ıit.	
	Address: 0x27								omina	l Valı	1e :	ch	ips_p	er_sy	m
							Bit M	lap							
B15	B14	B13	B12	B11	B10	В9	B8	B7	В6	B5	B4	В3	B2	B1	В0
D15	D14	D13	D12	D11	D10	D9	D8	D7	D6	D5	D4	D3	D2	D1	D0

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 $D[15..0] \leftrightarrow$ Number of chips per symbol. This is nominally the same as the chips_per_sym control register, but could be varied to obtain a different hold-up duration without affecting other aspects of the demodulation.

3.40 pll_arst

Nam	e:	PLL a	asyncl	nronou	ıs rese	t.									
Desc	: :	clock EPLI	The DCC output clock is retimed in the DDP to produce the master chip-rate clock used throughout the DSSS FW. Retiming is achieved with an embedded EPLL (enhanced PLL) entity in the FPGA. This register is the reset control for the embedded PLL. Solve 1.												
								N	omina	l Valı	1e:		0x0	0000	
							Bit I	Map							
B15	B14	B13	B12	B11	B10	В9	В8	B7	В6	B5	B4	В3	B2	B1	ВО
Х	Х	Х	Χ	Х	Х	Х	Х	Х	X	Х	Х	Х	Х	Х	Clr

 $X \rightarrow Don't$ care.

 $Clr \leftrightarrow Asynchronous reset (ACTIVE HIGH)$. Resets the EPLL entity.

3.41 bsif_fifo_clr

Nam	ie:	Bitstı	ream i	nterfa	ce FIF	O clea	ar.								
Desc	2:				-					00	g demo or that			ıta ove	er
	the PCI interface. This register Address: 0x29							N	omina	l Valı	1e:		0x0	0000	
							Bit 1	Мар							
B15	B14	B13	B12	B11	B10	В9	B8	B7	В6	B5	B4	В3	B2	B1	В0
Х	Х	Х	Х	Х	Х	Х	Х	Х	Х	Х	Х	Х	Х	Χ	Clr

 $X \rightarrow Don't$ care.

 $Clr \leftrightarrow Asynchronous reset$ (ACTIVE HIGH). Resets the FIFO buffer. The FIFO should be reset before logging to disk to avoid overflows and junk data.

3.42 ddc_ph_msw

Nam	ie:	Digit	al Do	wncon	ıvertei	: (DD0	C) pha	ise inc	remer	nt – mo	ost sig	nifica	nt wo	rd.	
Desc	! :	the u	pper î	FW im 16-bits onvers	of the	e 3 2- bi	t phas	se incr	ement			,	_	-	
	the downconversion LO within the downconversi							No	minal	l Valu	e :	(fo	0x5 or 70 l		F)
							Bit I	Мар							
B15	B14	B13	B12	B11	B10	В9	В8	В7	В6	В5	B4	В3	B2	B1	В0
P31	P30	P29	P28	P27	P26	P25	P24	P23	P22	P21	P20	P19	P18	P17	P16

P[31..16] \leftrightarrow Upper 16-bits of the DDC DDS phase word. The phase increment word ($\Delta \phi$, 32-bits) follows from the required downconversion frequency (f_{LO} , in MHz) and sample rate (f_s , fixed at 200MSPS) as follows :

$$\Delta \phi = 2^{32} * (f_{LO} / 200)$$

3.43 ddc_ph_lsw

Nam	e:	Digit	al Do	wncon	vertei	: (DD0	C) pha	se inc	ereme	nt – le	ast sig	gnifica	ınt wo	rd.	
Desc	! :	the lo	The DSSS FW implements a DDC stage at the front end. This register specifies the lower 16-bits of the 32-bit phase increment word for the DDS that generates the downconversion LO within the DDC. Separate State												
	Address:				0x2	В		No	mina	l Valu	ie:	(fe	0x9 or 70 l		F)
							Bit N	Лар							
B15	B14	B13	B12	B11	B10	В9	B8	В7	В6	В5	B4	В3	B2	B1	В0
P15	P14	P13	P12	P11	P10	P9	P8	P7	P6	P5	P4	Р3	P2	P1	Р0

 $P[15..0] \leftrightarrow Lower 16$ -bits of the DDC DDS phase word. Refer to register ddc_ph_msw to determine the required value.

3.44 ddc_rst

Nam	e:	Digit	tal Do	wncon	vertei	(DDC	C) res	et.							
Desc	! :	The DSSS FW implements a DDC stage at the front end. This register enables or disables (bypasses) the DDC. dress: 0x2C Nominal Value: 0x0000													
	Address: 0x2C								mina	l Valu	ie:		0x0	000	
							Bit N	Лар							
B15	B14	B13	B12	B11	B10	В9	B8	B7	В6	B5	B4	В3	B2	B1	ВО
Х	Χ	Χ	X	Х	X	Χ	Χ	Х	Х	Х	Х	Χ	Х	Χ	Rst

 $X \rightarrow Don't$ care.

Rst \leftrightarrow DDC reset (ACTIVE HIGH). When asserted, the DDC DDS phase accumulator is held at zero, and the DDC stage is effectively bypassed (sampled data passed without downconversion). When deasserted, a downconversion at the programmed frequency shift is applied to sampled data.

4. Status Register Definitions

Status registers allow asynchronous observation of DSSS FW processes. There are 15 x 16-bit registers, referenced by their firmware signal name and listed in order of increasing address offset within the DSSS memory map. The memory mapping of registers is defined in the VHDL file $dsss_gbbm_port.vhd$.

4.1 interp_status/agc_status

Nam	ie:	Inter	polato	or and	AGC	status	•								
Desc	::			ed stat ator co				-		-	olato	rs.			
	The attenuator control word fr Address: 0x60							No	minal	l Valu	ie:		N,	/A	
							Bit N	Лар							
B15	B14	B13	B12	B11	B10	В9	B8	В7	В6	В5	B4	В3	B2	B1	В0
A7	A6	A5	A4	A3	A2	A1	A0	Х	Χ	Х	Х	Х	I2	I1	Ι0

$X \rightarrow Don't$ care.

I[2..0] \leftrightarrow Encoded interpolator state vector. This will return in the range 0..3. It is the optimum sampling state when interpolating in automatic mode (under control of the ELDLL tracking loop) or the set value when in manual (BITE) mode.

 $A[7..0] \leftrightarrow 8$ -bit attenuator control word for digital attenuators in the RF downconverter. It is either governed by the AGC loop when AGC is selected or specified manually when the AGC loop is bypassed.

4.2 acq_status

Nam	ie:	Acqu	uisitio	n cont	roller	status	S.								
Desc	Monitors the status of the acquisition controller, including the state of the acquired flag (ACQD), the activity state of the local PN codes, and the current position in the dwell tree.														
	Addı	ess:			0x6	1		No	minal	l Valu	ıe:		N	N/A	
							Bit I	Мар							
B15	B14	B13	B12	B11	B10	В9	B8	B7	В6	B5	B4	В3	B2	B1	В0

Х	X X	х	X X	Х	X	Χ	Χ	Χ	D2	D1	D0	Ena	Acqd	
---	-----	---	-----	---	---	---	---	---	----	----	----	-----	------	--

 $X \rightarrow Don't$ care.

Acqd ↔ The acquisition status flag. When HIGH the state is 'acquired', when LOW the state is 'not acquired'.

Ena \leftrightarrow The activity state of the local PN codes. When LOW the local codes are static and the controller is waiting for a high correlation score event to trigger continuous dynamic testing. When high, the controller is either priming the acquisition correlators with the correctly phased sequences of PN codes before resuming testing (e.g. after failing an acquisition attempt or losing a previously acquired state), or is clocking the local PN sequences in time with the received signal and updating the correlation status once per N chips, where N is the current correlator length.

 $D[2..0] \leftrightarrow$ Acquisition state in terms of current height in the dwell tree. In the unacquired state, the height/dwell will be zero (bottom of the tree). Then as subsequent tests return above or below the thresholds, an increment or decrement to the dwell state will be made until the maximum dwell height is reached (ACQD is asserted) or the minimum dwell state is reached (ACQD is deasserted).

4.3 str_samp_status

Nam	e :	Syml	ool tim	ing re	covery	sam	ple pl	nase.							
Desc	:	Moni	itors th	ne STR	loop t	iming	g inst	ant.							
	Addı	ddress: 0x62 Nominal Value: N/A													
							Bit M	Iap							
B15	B14	B13	B12	B11	B10	В9	B8	B7	В6	B5	B4	В3	B2	B1	ВО
D15	D14	D13	D12	D11	D10	D9	D8	D7	D6	D5	D4	D3	D2	D1	D0

D[15..0] \leftrightarrow The current 'phase' of the STR output clock. For a symbol spread at N chips per symbol, the sample phase may be anywhere in the range 0 to N-1, given that the STR loop counters are wholly asynchronous to the actual start positions of symbol edges. Valid STR is indicated by a static or 'slowly' drifting phase (provided that the STR loop gain is not so low as to inhibit phase updates).

4.4 str_lock_status

Nam	ie:	Sym	bol tin	ning re	ecover	y LO	CK st	atus.							
Desc	2:			he STI lator s		K flag	g. Als	o moi	nitors	the d	emod	ulate	d data	strea	m and
	Addı	ddress: 0x63 Nominal Value: N/A													
							Bit 1	Мар							
B15	B14	B13	B12	B11	B10	В9	B8	B7	В6	B5	B4	В3	B2	B1	В0
Х	Х	Х	Х	Х	Х	Х	Х	Х	Х	I1	Ι0	D	DQ	DI	Lock

 $X \rightarrow Don't$ care.

Lock ↔ The STR LOCK flag. When asserted HIGH, the variation between the *str_samp_status* from one STR clock event to the next was within a user-defined lock margin.

 $DI \leftrightarrow The data decoded from the I-component of the detected symbol stream, which varies at the symbol rate.$

 $DQ \leftrightarrow$ The data decoded from the Q-component of the detected symbol stream, which varies at the symbol rate.

 $D \leftrightarrow The interleaved I/Q data$, which varies at the bit rate.

 $I[1..0] \leftrightarrow$ The two significant bits of the interpolator state encoding.

4.5 prbs_offset

Name:	PRBS offset count.
Desc:	The PRBS offset count provides a relative measure of the chip clock error between the transmitter and receiver. As the ELDLL tracks the optimum sampling state, and because the DSSS receiver operates in a noncoherent mode with imperfect carrier and modulation timing, the optimum sampling state will tend to drift from one code phase (chip) to an adjacent code phase (chip). To maintain acquisition the local PN codes must be advanced or retarded by one chip depending on the direction of the drift in the input signal. At each increment or decrement of the local code phase, the PRBS offset counter is similarly incremented or decremented. Thus independent observations of the offset count value will show an increase or decrease in proportion to the chip error.

	Addı	ess:			0x64	4		No	mina	l Valı	1e :		N	I/A	
							Bit M	ap							
B15	B14	B13	B12	B11	B10	В9	B8	B7	В6	B5	B4	В3	B2	B1	В0
D15	D14	D13	D12	D11	D10	D9	D8	D7	D6	D5	D4	D3	D2	D1	D0

 $D[15..0] \leftrightarrow$ The PRBS offset count value. If the PRBS Generators are reset this value is returned to zero. Only the relative change between two successive samples of this register is significant.

4.6 isym_mag

Nam	e :	I-cha	nnel s	ymbol	magni	itude.									
Desc	:			ned re	•				\sim		the I-	comp	onen	t of th	e
	Addı	Address: 0x65 Nominal Value: N/A													
						•	Bit M	lap							
B15	B14	B13	B12	B11	B10	В9	B8	B7	В6	В5	B4	В3	B2	B1	В0
D15	D14	D13	D12	D11	D10	D9	D8	D7	D6	D5	D4	D3	D2	D1	D0

 $D[15..0] \leftrightarrow 1$'s complement signed magnitude Y_I .

4.7 qsym_mag

Nam	e:	Q-ch	annel	symbo	l magı	nitud	e.								
Desc	:		_	ned re	•				0		the Ç)-com	pone	nt of t	he
	Addı	(despread) symbol stream (symbol $Y = Y_I + j^*Y_Q$). ress: $0x66$ Nominal Value: N/A													
							Bit M	lap							
B15	B14	B13	B12	B11	B10	В9	B8	B7	В6	B5	B4	В3	B2	B1	ВО

		D15	D14	D13	D12	D11	D10	D9	D8	D7	D6	D5	D4	D3	D2	D1	D0
--	--	-----	-----	-----	-----	-----	-----	----	----	----	----	----	----	----	----	----	----

 $D[15..0] \leftrightarrow 1$'s complement signed magnitude Y_Q .

4.8 dsym_mag

Nam	e :	Diffe	rential	symb	ol mag	gnituo	de.								
Desc	:			signed symbo					0			•			Y _{da}).
	(despread) symbol stream after differential detection. (symbol Y = $Y_{dm} \angle Y_{da}$). Address: 0x67 Nominal Value: N/A														
							Bit M	lap							
B15	B14	B13	B12	B11	B10	В9	B8	B7	В6	B5	B4	В3	B2	B1	В0
D15	D14	D13	D12	D11	D10	D9	D8	D7	D6	D5	D4	D3	D2	D1	D0

 $D[15..0] \leftrightarrow 16$ -bit unsigned magnitude Y_{dm} .

4.9 dsym_pha

Nam	ie:	Diffe	rentia	l syml	ool ph	ase.									
Desc	2:	syml Also	ool str	gned ream after the latest the latest the latest the latest lates	fter di currer	fferen it vali	tial d ue on	etecti	on. (s	ymbo	1Y =	$Y_{dm} \angle$	Y_{da}).	,	
	Addı	configure the DDS on the DCC. dress: 0x68 Nominal Value: N/A													
							Bit I	Мар							
B15	B14	B13	B12	B11	B10	В9	B8	B7	В6	B5	B4	В3	B2	B1	В0
D7	D6	D5	D4	D3	D2	D1	D0	A7	A6	A5	A4	A3	A2	A1	A0

 $\mathrm{D[7..0]} \leftrightarrow \mathrm{The}\ \mathrm{status}\ \mathrm{of}\ \mathrm{the}\ \mathrm{DDS}\ \mathrm{configuration}\ \mathrm{data}\ \mathrm{port}.$

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 $A[7..0] \leftrightarrow 8$ -bit 1's complement signed angle Y_{da} .

4.10 afc_lsw

Nam	ie:	AFC	loop l	east si	gnific	ant w	ord.								
Desc	:	The l	ower	16-bits	s of the	e 3 2- b	it AF	C set-	point	word	l.				
	Addı	lress: 0x69 Nominal Value: N/A													
							Bit 1	Мар							
B15	B14	B13	B12	B11	B10	В9	B8	B7	В6	B5	B4	В3	B2	B1	В0
F15	F14	F13	F12	F11	F10	F9	F8	F7	F6	F5	F4	F3	F2	F1	F0

 $F[15..0] \leftrightarrow LSW$ of the AFC set-point word.

4.11 afc_msw

Nam	ie:	AFC	loop	most s	ignific	ant w	ord.								
Desc	:	The 1	upper	16-bit	s of th	e 32-b	it AF0	C set-p	oint v	word.					
	Address: 0x6A Nominal Value: N/A														
							Bit N	Лар							
B15	B14	B13	B12	B11	B10	В9	В8	В7	В6	В5	B4	В3	B2	B1	В0
F31	F30	F29	F28	F27	F26	F25	F24	F23	F22	F21	F20	F19	F18	F17	F16

 $F[31..16] \leftrightarrow MSW$ of the AFC set-point word.

4.12 clkset_busy

Name:

Desc	Desc: When the chip_clk EPLL is being reconfigured, this bit is set high.														
	Address: 0x6B Nominal Value: N/A														
	Bit Map														
B15	B14	B13	B12	B11	B10	В9	B8	B7	В6	B5	B4	В3	B2	B1	В0
X	Х	Х	X	X	Х	Χ	Χ	Х	Χ	Χ	Х	Χ	Χ	Х	BSY

 $X \rightarrow Don't$ care.

BSY ↔ Status of the chip_clk EPLL configuration process. When asserted HIGH, the configuration controller is busy processing the previous update request.

4.13 fifo_status

Nam	ie:	FIFC	FIFO fill status.												
Desc	Desc: Returns the state of the data capture FIFO EMPTY and FULL flags.														
Address: 0x6C Nominal Value:							N/A								
	Bit Map														
B15	B14	B13	B12	B11	B10	В9	B8	B7	В6	B5	B4	В3	B2	B1	В0
X	х	х	Χ	Х	Х	Х	Х	Х	Х	Х	Х	Χ	Х	nF	nE

 $X \rightarrow Don't$ care.

nE ↔ FIFO Empty flag (ACTIVE LOW).

 $nF \leftrightarrow FIFO$ Full flag (ACTIVE LOW).

4.14 bsif_status

Nam	ie:	Bitst	Bitstream interface FIFO status.												
Desc	Pesc: Returns the state of the bitstream interface FIFO.														
Address: 0x6D Nominal Val							l Valı	ıe :	N/A						
	Bit Map														
B15	B14	B13	B12	B11	B10	В9	В8	B7	В6	B5	B4	В3	B2	B1	В0
X	X	Χ	X X X X X X X X X OVF RDY												

 $X \rightarrow Don't$ care.

RDY ↔ Ready flag (ACTIVE HIGH). When this bit is asserted, there is a FIFO-full of logged data to be retrieved. This bit is not reset until the entire FIFO is emptied.

OVF \leftrightarrow Overflow flag (ACTIVE HIGH). When this bit is set there was an overflow during bitstream logging, i.e. one FIFO in the paged pair filled before the other one was emptied.

4.15 clkskew_test

Nam	ie:	Cloc	Clock skew test result.												
Desc	2:	Refer Section 2.2.1. This bit will be either consistently '1' or consistently '0' depending on the relative synchronisation of the ADCs.													
	Address: 0x6E							Nominal Value :			N/A				
	Bit Map														
B15	B14	B13	B12	B11	B10	В9	B8	B7	В6	B5	B4	В3	B2	B1	В0
Х	х	Х	Χ	Х	Х	Х	Х	Х	Х	Х	Х	Х	Х	Х	SK

 $X \rightarrow Don't$ care.

 $SK \leftrightarrow Skew state$.

5. FIFO Signal Capture Interface

The FIFO1 (Signal Monitoring) Receiver Interface (Section 2.2.6) allows signals internal to the DSSS signal processing chain to be captured in a FIFO at a known sample rate and extracted to the host as a contiguous block of data for subsequent analysis purposes, typically quasireal-time graphical display.

Signals of interest are mapped to the available sets of *input channels* in FW. Depending on the current *packing mode*, a subset of input channels is selected for input to the FIFO in a certain order. The FIFO has a 64k x 32-bit arrangement and is clocked at a fixed rate equal to half the chip rate.

The partitioning of input channels into sets, and the use of the half-rate chip clock as sample clock, are legacies of the first generation HW architecture, and were preserved in the migration to the DPC for compatibility with the Development GUI.

5.1 Input Channels

Input channels are grouped into sets, and two types of set are implemented, namely fast sets and slow sets. Fast sets are designated s#f(5..0) and provide 6 x 8-bit inputs. Slow sets are designated s#s(11..0) and provide 12 x 16-bit inputs. The DSSS FW facilitates '#', the set number, in the range 0 to 2.

The fast channels are double-buffered internal to the interface to allow sampling at the full chip rate. Here, 16-bits of the input word are allocated to simultaneously log both the current 8-bit sample and its predecessor.

The slow rate channels are typically interleaved in the packing circuit, giving more signals but at a slower rate.

The mapping of signals to input channels is scripted in the VHDL file *dsss_gbbm_port.vhd*.

5.2 Packing Modes

The packing mode is set via the *fifo_ctrl* register (Section 3.38). The same register controls resetting and filling operations. When the FIFO is full it sets a bit in the *fifo_status* register (Section 4.13).

The packing operations are defined in the VHDL file $dsss_fifopacker.vhd$, and are summarised in the following table, where R_c is the chip rate and the suffix 'd' on a channel designation implies the double-buffered (previous) sample.

Mode	Channe	ls Logged	and Samp	le Rates	32-bit Word Format						
					3124	2316	158	70			
0	s2f(0)	R_c	s2f(2)	R_c	s2f(2)d	s2f(0)d	s2f(2)	s2f(0)			
1	s2f(1)	R_c	s2f(2)	R_c	s2f(2)d	s2f(1)d	s2f(2)	s2f(1)			
2	s2f(0)	R_c	s2f(3)	Rc	s2f(3)d	s2f(0)d	s2f(3)	s2f(0)			
3	s2f(1)	R_c	s2f(3)	R_c	s2f(3)d	s2f(1)d	s2f(3)	s2f(1)			
4	s2f(0)	R_c	s2f(2,4)	$R_c/2$	s2f(4)	s2f(0)d	s2f(2)	s2f(0)			
5	s2f(1)	R_c	s2f(3,4)	$R_c/2$	s2f(4)	s2f(1)d	s2f(3)	s2f(1)			
6	s1f(0)	R_c	s1f(1)	R_c	s1f(1)d	s1f(0)d	s1f(1)	s1f(0)			
7	s1f(2)	R_c	s1f(3)	R_c	s1f(3)d	s1f(2)d	s1f(3)	s1f(2)			
8	s1f(0,1)	$R_c/2$	s1f(2,3)	$R_c/2$	s1f(3)d	s1f(2)d	s1f(1)	s1f(0)			
9	s0f(0)	R_c	s0f(1)	R_c	s0f(1)d	s0f(0)d	s0f(1)	s0f(0)			
10	s0f(2)	R_c	s0f(3)	R_c	s0f(3)d	s0f(2)d	s0f(3)	s0f(2)			
11	s0f(4)	R_c	s0f(5)	R_c	s0f(5)d	s0f(4)d	s0f(5)	s0f(4)			
12	s0f(1)	R_c	s0f(2)	R_c	s0f(2)d	s0f(1)d	s0f(2)	s0f(1)			
1315	s0s(0)	$R_c/12$	s0f(0,1)	$R_c/2$	s0s	s(0)	s0f(1)	s0f(0)			
	s0s(1)	$R_c/12$			s0s	s(1)	s0f(1)	s0f(0)			
	s0s(2)	$R_c/12$			s0s	s(2)	s0f(1)	s0f(0)			
	s0s(3)	$R_c/12$			s0s	s(3)	s0f(1)	s0f(0)			
	s0s(4)	$R_c/12$			s0s	s(4)	s0f(1)	s0f(0)			
	s0s(5)	$R_c/12$			s0s	s(5)	s0f(1)	s0f(0)			
	s0s(6)	$R_c/12$			s0s	s(6)	s0f(1)	s0f(0)			
	s0s(7)	R _c /12			s0s	s(7)	s0f(1)	s0f(0)			
	s0s(8)	$R_c/12$			s0s	s(8)	s0f(1)	s0f(0)			
	s0s(9)	$R_c/12$			s0s	s(9)	s0f(1)	s0f(0)			
	s0s(10)	$R_c/12$			s0s	(10)	s0f(1)	s0f(0)			
	s0s(11)	$R_c/12$			s0s	(11)	s0f(1)	s0f(0)			

6. Receiver Configuration and Operation

A representative approach to DSSS Receiver configuration and operation is illustrated by the flowcharts in Section 6.1. Each state in the flowcharts is explained in Section 6.2. Values given in examples describe a DPC hosted in a desktop PC running Redhat Linux 9.0, configured for a 2 Mbps message spread at 50 MCPS, and with 0dB chip SNR at the input. Suitable driver and interface SW are assumed.

6.1 Event Flowchart: Power-up to Demodulation

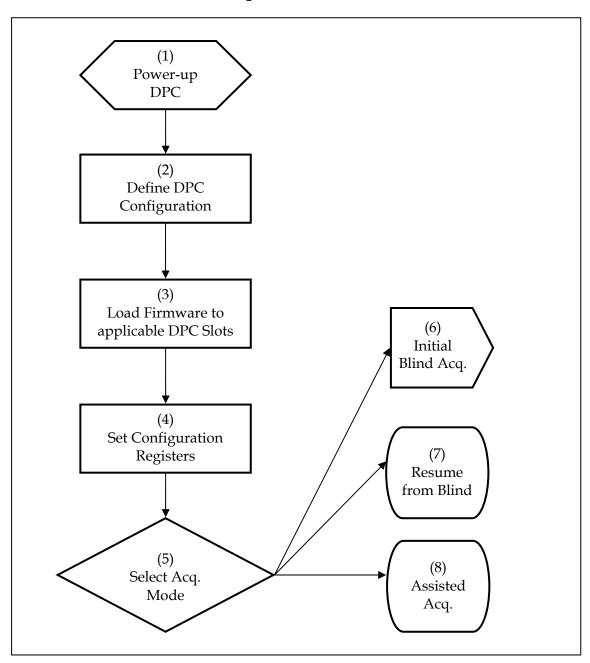


Figure 4-System Flowchart Sheet 1 of 4

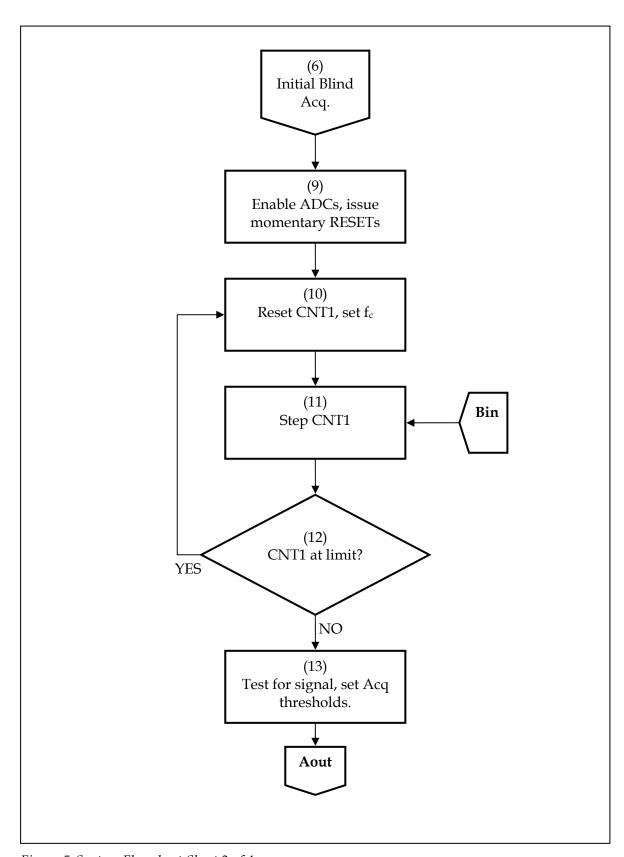
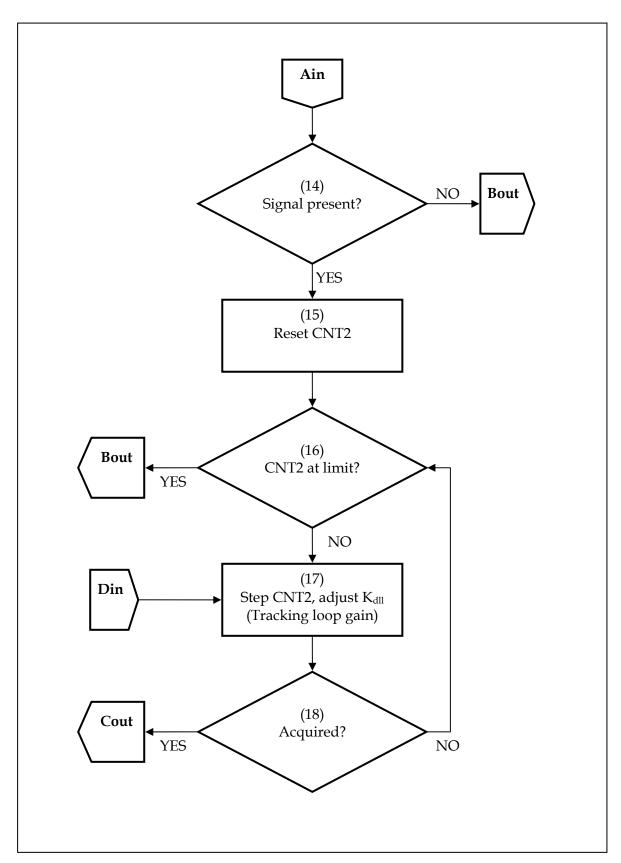


Figure 5-System Flowchart Sheet 2 of 4



 $Figure\ 6\hbox{-}System\ Flowchart\ Sheet\ 3\ of\ 4$

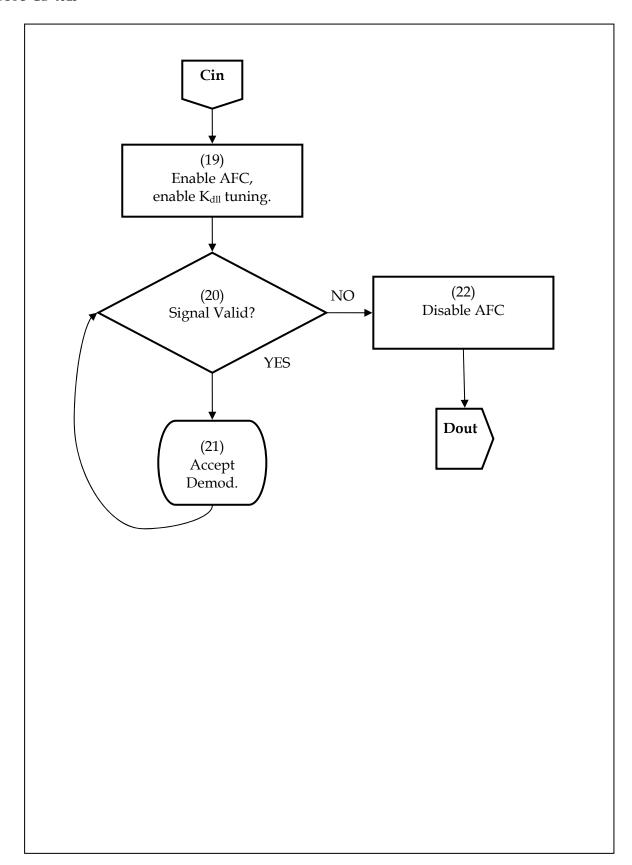


Figure 7-System Flowchart Sheet 4 of 4

6.2 Flowchart Event Descriptions

6.2.1 Power-up

6.2.1.1 State (1)

When power is applied to the host, the PCI Target FW and a small set of application-side PCI peripherals will be loaded into the mainboard EP1S10 FPGA by the EPC8 boot EEPROM. The DPC should be registered as a valid PCI device by the host BIOS, and will be available to interact with device driver SW.

In the Linux /proc/pci listing the DPC might appear as follows :

```
Bus 4, device 1, function 0:
Signal processing controller: PCI device 0011:0012 (rev 0).
IRQ 3.
Non-prefetchable 32 bit memory at 0xdb000000 [0xdbffffff].
```

Note that the memory allocation spans 16MB (0xFFFFFF) as requested in FW. The identity label and device numbers will be constant from platform to platform.

Without further activity, the DPC will be idle on the PCI bus, with the Slot#1 DDP unconfigured (all FPGA User-I/O will be tri-stated), and hence with the Slot#0 DCC state unknown (but since the ADC enable strobe is active-LOW, the ADCs may be clocking at full rate).

In a development environment there may be changes to the EP1S10 FW. These may be uploaded to the EPC8, necessitating a shutdown for the changes to take effect on the next power-up, or directly to the FPGA, necessitating a reboot for the changes to take effect.

When stable, a DPC device driver should be installed, and the desired UI SW should be launched.

6.2.2 Device Initialisations

6.2.2.1 State (2)

In general purpose UI SW, the state of the DPC module configuration will be variable and hence must be defined for each application. This example assumes that the DPC has a DCC in Slot#0, a DDP in Slot#1, and that Slots#2 and #3 are either unloaded or loaded but will not be programmed. It may be necessary to specify the intended configuration and expected usage to enable SW to check that all necessary Slots are loaded prior to continuing.

6.2.2.2 State (3)

The DSSS FW application must be uploaded into the Slot#1 FPGA. The DPC has a Configuration peripheral, memory-mapped to the following array segment:

```
dsss pci cnfq[ 0x40]
```

This peripheral provides access to the configuration control and status pins of each loaded DDP FPGA (indexed by Slot#), in accordance with the following scheme, where on the PCI interface the write strobe, chip-select (for the Conf. Peripheral), and lower 3 address bits are significant:

 1_w	r l_	cs	1_a[2]	l_a[1]	1_a[0] Description
 ===		===			===========
 1	1	0	0	0	Write to Control Register 0
 1	1	0	0	1	Write to Control Register 1
 1	1	0	1	0	Write to Control Register 2
 1	1	0	1	1	Write to Control Register 3
 0	1	0	0	0	Read from Status Register 0
 0	1	0	0	1	Read from Status Register 1
 0	1	0	1	0	Read from Status Register 2
 0	1	0	1	1	Read from Status Register 3
 1	1	1	X	X	Write Configuration Data Byte

The FPGA configuration file must be in the Altera tabular text file (.ttf) format. It must be opened for reading, read and transferred in accordance with a specific algorithm, an example of which is provided in the software utility referenced in Section 7. The following header extract defines the core functionality that this code implements:

```
Function:
            fpga_cfg_main
Description:
  Main function for configuration. Performs the following:
  - Calls if_chk_inputs to check inputs provided.
  - Calls if_init to initialise signals/buffers.
  - Does setup: Set nCONFIG low, wait 40us, set nCONFIG high, set nCS
          low, wait 40 us
  - Reads from configuration file and extracts a config byte to write.
   Writes configuration byte to FPGA, Reads nSTATUS, CONF_DONE and
   INIT_DONE. Exits if nSTATUS low. Repeats this until all bytes sent.
  - Reads nSTATUS, CONF_DONE and INIT_DONE. Exits if nSTATUS low.
   Checks if CONF_DONE high, if so checks if INIT_DONE high. Repeats
   until CONF_DONE and INIT_DONE are both high. Now Config is complete.
  - Calls if_cleanup to reinitialise signals/buffers.
  Returns 0 if successful or < 0 if there is an error.
```

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The DSSS FW application is then available (FPGA user I/O are active, and the DSSS will respond as a peripheral on the back-end PCI-bus in accordance with its defined memory map) but unconfigured.

6.2.2.3 State (4)

The DPC state and DSSS operating mode are defined by configuration registers. The following settings form a consistent example.

ADDR	Name	Nominal	Comment
(0x)		Value (0x)	
00	fir_bypass	0000	FIR filters would normally be in-line.
01	reset_ctrl	2DFF	See Note(1) below.
02	interp_ctrl	0000	Automatic (ELDLL) interpolator control.
03	agc_dwell	4E20	Dwell for 20000 chips.
04	agc_thresh	07D0	Target 10% full-scale events.
05	agc_gain	0003	Good steady-state response.
06	agc_ctrl	0000	Automatic AGC (manual value at 0dB).
07	acq_thresh0	0032	See Note (2) below.
08	acq_thresh1	0014	See Note (2) below.
09	acq_thresh2	0014	See Note (2) below.
0A	acq_thresh3	0014	See Note (2) below.
0B	acq_thresh4	0014	See Note (2) below.
0C	acq_thresh5	0014	See Note (2) below.
0D	acq_thresh6	0014	See Note (2) below.
0E	acq_thresh7	0014	See Note (2) below.
0F	acq_serdwell	0000	Don't care, not using serial acq. Mode.
10	acq_ctrl	0010	Parallel correlation in the 512 x 1-bit mode.
			Acq. dwell tree height is 2 (two
			verifications after the initial acquisition).
11	chips_per_sym	0032	Based on the assumed 2 Mbps (1MSps)
			and 50 MCPS.
12	acqh_Nsym	0064	100 symbols of hold-up time. Known good
			value from development testing.
13	dll_gain	0087	$K_{dll} = 2.73e-2$. See Note (3) below.
14	dll_dwell	0020	Tracking loop dwell of 32 chips is
			appropriate for this high data rate case.
15	iprbs_tap	236D	14 th order PRBS with tap word 43333
			(sequence length 16383 chips long).
16	iprbs_pha	000F	Arbitrary.
17	iprbs_ospha	3857	Calculated w.r.t. "iprbs_pha".
18	qprbs_tap	2421	14 th order PRBS with tap word 44103
			(sequence length 16383 chips long).

ADDR	Name	Nominal	Comment
(0x)		Value (0x)	
19	qprbs_pha	0001	Arbitrary.
1A	qprbs_ospha	1986	Calculated w.r.t. "qprbs_pha".
1B	mode_dds_ctrl	0020	The DDS interface is idle. PRBS loopback
			and ACQ testing is off. The demod. mode
			is QPSK.
1C	str_dwell	002F	Follows as chips_per_sym – 3.
1D	str_gain	008B	$K_{\text{str}} = 4.30\text{e-}2$. Known good point at this
			data rate from development testing.
1E	str_lock_margin	0005	10% (say) of chips_per_sym.
1F	dds_msw	1B63	For nominal 10.7 MHz, if used.
20	dds_lsw	8906	For nominal 10.7 MHz, if used.
21	afc_rate	0800	Update once per 2048 symbols. Known
			good rate from development testing.
22	ddet_gain	0009	Known good point from development
			testing for moderate SNR.
24	clkset_data	4800	See Note (4) below.
25	clkset_ctrl	0000	See Note (4) below.
26	fifo_ctrl	000F	FIFO packing is disabled, the mode is '7'
			(arbitrary) and the CLR strobe is asserted
			when the FIFO is unused.
27	acqh_symlen	03E8	In conjunction with "acqh_Nsym",
			provides sufficient hold-up. Nominal
			length of 1000 chips does not have to
			match the actual chips_per_sym.
28	pll_arst	0000	The PLL is not reset (the chip clock is
			active if programmed).
29	bsif_fifo_clr	0000	This bitstream logger FIFO is not reset.
2A	ddc_ph_msw	5999	For nominal 70 MHz.
2B	ddc_ph_lsw	999A	For nominal 70 MHz.
2C	ddc_rst	0000	The DDC is not reset.

Notes:

1. This assumes that AFC is enabled. If AFC is disabled, as prior to acquisition or otherwise, then the nominal value is 0x2CFF. To reset all functions, issue 0x0000 (AFC OFF).

Further, this is the register via which ADCs are enabled. The given values assume ADCs are enabled. If ADCs are disabled, the normal (non-reset) condition is 0x3CFF (AFC OFF) or 0x3DFF (AFC ON). Similarly the reset condition becomes 0x1000 (AFC OFF).

In establishing the correct ADC synchronisation (Section 2.2.1), the ADCs would be turned OFF (0x3CFF) then ON again (0x2CFF), and the resultant skew status bit at

register address 0x6E would be polled. The detail of this approach resides in the code of the Development GUI, discussed at Section 7.

2. An automatic routine for setting acquisition thresholds has been developed. Here the on-time acquisition scores are monitored via the data-capture FIFO interface, under a variety of conditions. First, the local spreading codes are set to erroneous sequences, to establish the correlation noise floor (in the absence of any true correlation events). Then, the correct sequences are loaded with high threshold levels, and the peak values that result from unsustained correlation bursts are determined. Then the initial threshold point is set at a percentage of the difference, added to the noise floor, and the remaining thresholds are set at a user-defined fraction of the initial threshold (typically 50%). The detail of this algorithm resides in the code of the Development GUI, discussed at Section 7.

To set thresholds manually, the first threshold may be decreased from an initial high value while monitoring the on-time acquisition scores in a plot window and with the tracking loop gain set mid-range. The other thresholds can follow a 50% rule. When acquisition events become apparent, the tracking loop gain should be adjusted to see if acquisition is sustainable, otherwise the thresholds may still be too high.

3. The given value applies only to an AWGN channel with received chip SNR near 0dB. In general the required gain is a function of the signal quality and channel characteristics. An automatic routine for determining the correct gain setting has been developed. Here, the interpolator state vector is monitored via the signal capture interface. As the tracking loop adjusts the interpolator output state to maintain the optimum on-time sampling instant, the state bits toggle from one state to an adjacent state. However because the tracking is a noisy process, there will be not one single transition but a number of transitions back and forth as the loop settles to the new state. This 'state jitter' varies as a function of loop gain consistent with normal loop theory (i.e. high gain implies a broad pull-in range (bandwidth) but high jitter whereas low gain narrows the pull-in range and improves the jitter), and development testing has shown that optimum BER performance is linked to a defined amount of state jitter. Thus the gain setting process is to monitor the state vector, compute a jitter metric as the number of transitions per state change, averaged over sufficient blocks of data, then increment or decrement the loop gain to drive the jitter metric to within desired bounds. The detail of this algorithm resides in the code of the Development GUI, discussed at Section 7.

An operator may achieve the correct gain setting by manually adjusting the gain word while monitoring a real-time plot of the interpolator state vector and striving for the desired amount of jitter.

Note that due to the mantissa and exponent format of the gain word (Section 3.20) a simple increment or decrement to the gain value does not follow from a numeric increment or decrement of the word. Instead a look-up table is required, and an example is provided in the Development GUI (Section 7).

4. These two registers allow configuration of the variable elements in the enhanced phase-locked loop (EPLL) entity on the EP1S80 FPGA that provides the chip clock for DSSS signal processing. An EPLL accepts a single reference clock as input (f_{ref}) and can operate in several modes to produce up to six output clocks (f_{oi}) to the FPGA array. For any given output, the frequency is given by $f_{oi} = f_{ref}*M/(N*P_i)$, where M is a prescale multiplier, N is a pre-scale divider, and P_i is a post-scale divider for the i^{th} output. The output phase can also be controlled via delay parameters associated with each scaler, and the output duty cycle is controlled by splitting P_i into high and low components, $P_i = P_{i,hi} + P_{i,lo}$.

In the DSSS FW, the EPLL is instantiated with N=1 and uses only one of the output clocks (designated g_0 in Altera's PLL documentation). The input clock is the 100 MHz sample clock from the I-channel ADC, and the output is the chip clock which must have period 20ns or slower, in 10ns increments (in order to be compatible with the input sample decimation scheme, see Section 2.2.2). Thus the chip clock rate is set as

$$chip_clk (MHz) = 100*M/P$$

where $M \le 8$ (due to rate limitations in the embedded silicon), M and P must satisfy the 10ns period increment constraint, and P should have duty cycle as close to 50% as possible. Delay parameters D_M and D_P can also be set, with allowable range $0 \le D \le 12$ and with actual delay ΔT (ps) = 250*(D_M - D_P).

To program the EPLL each of the five variable parameters must be updated in a configuration register chain and a trigger signal must be sent to a configuration controller entity which will upload the entire chain for the new settings to take effect. An example of this sequence of events may be found in the development GUI, which is summarised by the code extracts:

```
// Update the chip clock PLL based on the M and P scaling and delay factors...
// Parameters from the user interface...
// M = sbConfigDemodValueMFactor->value();
// P = sbConfigDemodValuePFactor->value();
// DM = sbConfigDemodValueMDelay->value();
// DP = sbConfigDemodValuePDelay->value();
// Calculate high and low periods close to 50% duty cycle...
// if((P - floor((double)P/2)*2) == 0)
//{
// P_hi = P/2;
// P_lo = P/2;
//}
//else
//{
// P_hi = (P-1)/2;
// P_lo = P_hi +1;
//}
```

```
// Perform a sequence of writes to the PLL controller...
// Write the M value and wait until complete...
//driver->write_s1reg(PLL_DATA, 0x0200 + M);
//driver->write_s1reg(PLL_CTRL, PLL_WR);
//driver->write_s1reg(PLL_CTRL, 0);
//timeout = 5; //msec
//while(timeout > 0 && driver->read_s1reg(PLL_STATUS) == 1)
// qWarning("Waiting for Chip Clock PLL Controller...\n");
// usleep(1000);
// timeout--;
//}
// Write the P_hi value and wait until complete...
// Write the P_lo value and wait until complete...
// Write the M-Delay value and wait until complete...
// Write the P-Delay value and wait until complete...
// Update the PLL...
//driver->write_s1reg(PLL_CTRL, PLL_UPD);
//driver->write_s1reg(PLL_CTRL, 0);
```

The correct values for the delay parameters must be established by trial and error. For example, after updating the EPLL, check that with I_in and Q_in disconnected there are no spurious signals present in the sampled data streams, as logged via the data capture interface.

6.2.3 Select Acquisition Mode

```
6.2.3.1 State (5)
```

At this stage the DSSS Receiver is ready to begin acquiring a signal. It is assumed that a suitable RF downconverter has been used to provide a low IF or baseband quadrature input to the DPC analogue input ports. Note that the I and Q outputs from downconversion must map to the corresponding I and Q inputs on the DPC – if these channels are crossed over, the DSSS Receiver may appear to acquire and track a signal correctly, but will be unable to correctly demodulate the underlying QPSK symbols.

The signal will have (initially) unknown carrier frequency and SNR in a time varying fading channel, preventing exact *a priori* setting of the local frequency, acquisition thresholds and tracking loop gain.

A strategy must be chosen to manage these unknowns. The most general case is blind acquisition where there is no assumed knowledge and no added signal content to aid the acquisition process. With the exception of states (7) and (8), the remainder of this example assumes blind acquisition. An abbreviated process may be possible when resuming from a previously blind acquisition (Section 6.2.5) or when the signal content is modified to aid

acquisition. Proposals for the latter approach are given in Section 6.2.6, but note that these are not implemented in the Development GUI described in Section 7.

6.2.4 Initial Blind Acquisition

6.2.4.1 States (9 to 22)

The given process attempts to manage centre frequency searching, acquisition threshold setting, and tracking loop gain control. Much of this process is coded in the Development GUI (see Section 7).

These processes are nested within each other, and for any given setting of an outer process, the inner processes may or may not be successful. This leads to the idea of allowing an inner process to iterate only a bounded number of times before deciding that the outer process may also need adjusting, then regressing outwards.

Counters could be used to control these iterations. A counter CNT1 is proposed to regulate the overall number of acquisition attempts at any given centre frequency. CNT2 regulates the number of iterations of coarse gain setting before concluding acquisition failure.

So the proposed process is as follows. In state (9), momentarily reset the FW and ensure the ADCs are enabled with the correct (previously established) relative timing.

In state (10), choose a centre frequency and reset CNT1. For multiple iterations from this starting point, the centre frequency could be zigzag searched, i.e. started at the assumed centre frequency, then alternately incrementing and decrementing this value by increasing multiples of the AFC loop pull-in range (which is $+/-R_s/8$, i.e. check f_c , $f_c+/-2R_s/8$, $f_c+/-4R_s/8$, etc.). If user-defined bounds on centre frequency are reached (consistent with reasonable expectations on the stability and accuracy of the transmit and receive oscillators) then the search could be repeated or the conclusion that no signal is present could be reached.

In state (11), increment the counter CNT1. Then, provided that CNT1 has not expired, proceed to state (13) to test for the presence of a signal, as indicated by the existence of temporary correlation events in the correlator output scores. If a signal is present, the acquisition thresholds can be determined and updated with the automation algorithm (Section 6.2.2.3), or these could be programmed in accordance with a different scheme.

If strong correlations are occurring, reset CNT2 and (state 17) execute the automatic tracking loop gain routine (or otherwise set the tracking loop gain). Increment CNT2 when complete. If a loop gain that results in sustained acquisition cannot be found, and until CNT2 reaches its limit, repeat this test. If CNT2 expires, return to the acquisition threshold setting (state 11). Otherwise, the signal has been acquired and AFC should be enabled (state 19).

At this stage it is desirable to continuously test if the demodulated signal is valid or not (state 20). The ACQD flag provides a coarse indicator, but even when the acquired flag is asserted the demodulated signal may be invalid, for example if thresholds were set too low and the

local code phase is incorrect, or if the centre frequency is out by a multiple of $R_{\rm s}/4$, leading to excessive frequency error. Provided the signal is deemed valid, the demodulated data can be used (state 21). Otherwise, disable AFC before regressing backward via tracking loop gain adjustment, and if CNT2 expires via acquisition threshold setting, and if CNT1 expires via frequency stepping.

It may also be desirable to periodically check and adjust the tracking loop gain at this stage. This would be a fine-tuning of the gain and would be done without regressing through the process. An example of this process is provided in the Development GUI (Section 7).

The technique used for testing signal validity will depend on applications. Some confidence may be gained by executing a K-means style of SNR estimation on the recovered symbol constellation, to check that both the correct number of constellation clusters is present and that the SNR is meaningful (refer "Techniques for the Blind Estimation of Signal to Noise Ratio for Quadrature Modulated Signals", Parker, G., Proceedings of the fourth international symposium on signal processing and its applications, ISSPA '96, August 1996, vol.1, pp.238-241). In the event that the message contains known framing data, the presence of framing data could be checked periodically.

6.2.5 Resume from Blind

6.2.5.1 State (7)

If acquisition is being re-established after a previous successful transmission, if the elapsed time is short or the channel is known to be quite static, and if the transmitter and receiver oscillators are known to be quite stable, then the previous parameters may still be applicable and could be used as an informed starting point for demodulation. For example, direct entry to state (20) could be assumed (with CNT1 and CNT2 set to '1').

6.2.6 Assisted Acquisition

6.2.6.1 State (8)

The signal content could be modified to assist initial acquisition. This section suggests one possible approach, but note that these ideas are not yet incorporated in the Development GUI detailed in Section 7.

Conventional packet signalling schemes partition a packet into a series of frames, comprising preamble frames, a synchronisation frame, and the actual data frame.

The preamble is concerned with assisting carrier recovery and symbol timing recovery. A preamble might consist of a special sequence of symbols constructive to these processes, and of sufficient duration to allow the timing synchronisation to be achieved with some level of confidence.

The synchronisation frame is concerned with identifying the start of the following data frame. By far the most common approach to frame synchronisation (refer "Optimum Frame

Synchronisation", James L. Massey, IEEE Transactions on Communications Vol. COM-20, No.2) is the insertion of a unique word (UW) message, with optimised auto- and cross-correlation properties that seek to minimise the probability of false alarms and missed detections. When the UW is detected it is assumed both that the next symbol is data and that the prior timing recovery operations were successful.

With the DSSS Receiver, the packet structure might be similar to that shown in Figure 8, where it is important to recognise that the whole packet is spread (is a DSSS signal). Here, the following frames are proposed:

- An all 1s acquisition phase, which eliminates PRBS inversions due to data and prevents cancellation between the I and Q branches of the complex correlators.
- An all 1s tracking phase, which eliminates PRBS inversions due to data.
- An alternating 0/X, 1/X, 0/X, 1/X, ... I/Q-pattern which assists STR (the STR loop error detector provides an estimate of the timing error on a per-symbol basis, but the detector output is conditioned on a data polarity transition between one symbol and the next; thus successive 1s or 0s do not contribute to the error estimation). The STR loop only uses the I-channel information, so the Q-bit is 'don't care'.
- A UW frame synchronisation marker (or markers), for which a short PRBS or a Barker sequence would be sufficient. The UW correlation is implemented post-despreading, where the symbol SNR needs to be sufficiently large to allow a useful BER. Under these conditions, characterisation testing of the DSSS correlator circuits has shown that correlator performance is excellent (the output is at least 90% of the perfect score) which would allow robust threshold-based detection. A UW length of 31-symbols would provide 15dB of processing gain in the UW detection.

The UW could also provide additional benefits. Firstly, the UW detection event could be used to set a status bit (UW_Flag) that could be logged (interleaved, for example 1 bit in 32) with the data. This would provide confidence that the data is valid, and if the UW_Flag is reset by loss of acquisition it could be used to sense such events during the data frame. This UW_Flag would be expected within a known time interval of the start of acquisition and so, with simple FW time-stamping or counting, could also be used to trigger packet abort and retry if not present.

Secondly, UW events could be used to initiate and validate AFC. Upon UW detection, the Receiver has acquired the spread signal, is tracking chip timing errors and is despreading in-phase with the underlying symbols. It is then valid to enable AFC to reduce carrier noncoherence. If there are no UW events, or if after enabling AFC the UW events stop, then the frequency error may be too great and the AFC loop will pull-in to a centre frequency with offset (+/-) n*R_s/4 from the actual carrier frequency.

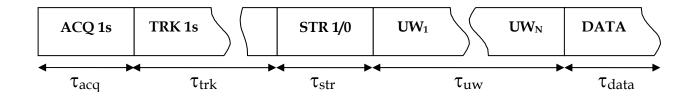


Figure 8- DSSS Signalling Packet Structure

In Figure 8, each frame should have an appropriate duration. The following considerations apply:

- τ_{acq} O(100ms): In an AWGN channel and using 14th-order (16383-long) PRBS, the acquisition time has been shown to be of the order of 10ms across a range of SNR. Increasing this by an order of magnitude for margin results in the 100ms estimate. Note that at 50 MCPS, this is approximately 300 iterations of the 14th-order sequence.
- τ_{trk} O(1s): The time required for tracking will depend largely on the SW scheme used for gain estimation. In the Development GUI a stepped gain search is conducted which takes several seconds to complete. This is likely to be the slowest component.
- τ_{str} O(1000 symbols): Measurements of the STR loop indicate several hundred symbols are required for loop pull-in. The duration of this frame will be a function of symbol rate; for example 1000 symbols at 2 Mbps requires 1ms whereas 1000 symbols at 20kbps requires 100ms.
- τ_{uw} O(N*31*T_s): For N repetitions of a 31-bit UW. A 1ms period allows 32 repetitions of a 31-bit UW at 2 Mbps. If UW repetitions are to facilitate AFC, then the duration should be consistent with the AFC update rate and the expected pull-in time of the AFC loop (typically O(100 symbols)).
- τ_{data} O(K*T_s): For K symbols in the frame.

Using the DSSS Receiver with structured packets may also lead to FW architecture variations. For example, the STR loop could be removed, with edge timing coming instead from a contrived relative alignment between the symbols and the spreading codes. This would be reestablished at the start of each data frame, as indicated by the UW detector. Another useful function that would be better facilitated by the adoption of a suitable packet structure is channel estimation, necessary in higher performance receiver equalisers.

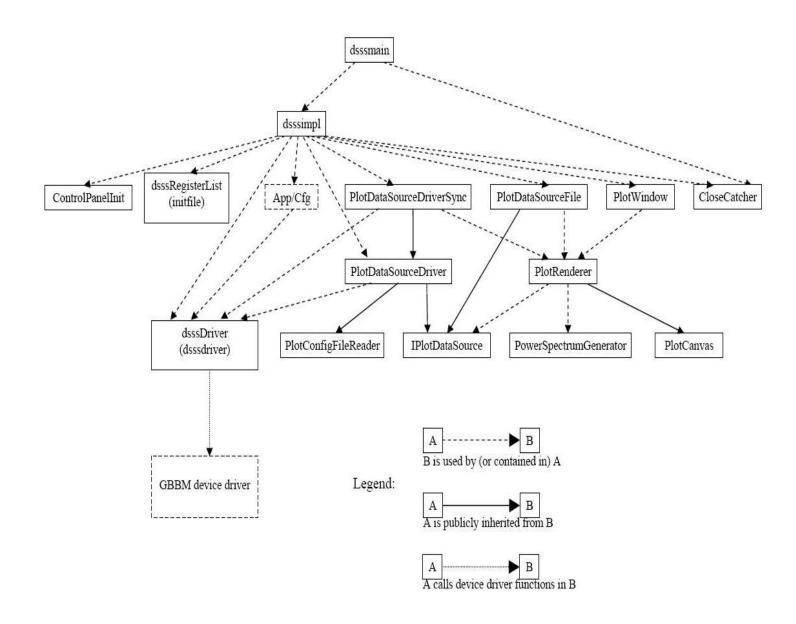
7. The DSTO Development GUI

The DSTO Development GUI is a complete interface to the DSSS Receiver for Redhat Linux 9.0 on an Intel 32-bit architecture PC. It comprises both device driver SW in 'C' and GUI SW in 'C++', as described in the following section. Reference is made here to the generic baseband modem (GBBM), a legacy designation for the DPC.

7.1 Code Hierarchy and Classes

The code hierarchy and classes are depicted in Figure 9. Note the following

- The software is configured as a Qt project, except for the GBBM device driver which is built independently of the project.
- Each box with solid edges represents a C++ class (except dsssmain this is the top-level "main" program). All the C++ class files are in the top-level directory. In general, the classes have the same name as the file (.cpp and/or .h); however those that differ show the class name followed by the filename in brackets. Only the higher level classes that are the main content of a file are shown.
- The boxes with dotted edges do not represent C++ classes.
- The GBBM device driver box represents the device driver C software, which consists of source (.c), header (.h) and makefiles in the driver subdirectory.
- The App/Cfg box represents the C software which is used for configuring the FPGA devices and Temperature Sensors on the GBBM card. This software is contained in the application and cfg_sw subdirectories and is written in C, although the files have a .cpp extension, to allow them to be used in the Qt project.
- There are some other files which exist in this software which are not indicated in the diagram. These are:
 - Extra header files (MyMacros.h) This contains some simple #define macros.
 - o GUI files (dssscontrol.ui, dssscontrol.ui.h) These hold the top-level GUI component and layout descriptions.
 - O Project files (dsss_ctrl.pro) This is the Qt project file which keeps track of the source (.cpp) and header (.h) files in the project.
 - o Compilation files (makefile) This is the file (generated using qmake) used by make to compile the project.
 - o Executable files (dsss_ctrl) This is the resulting executable from the compilation.
 - Config files (ControlPanelInitFile.cfg, PlotConfigFile.cfg) These hold initial values for the control panel controls and the modes available for plotting.
 - Hardware register list files (master.reg) This holds the name, size and address of the registers implemented in firmware that the DSSS application can access.



o Firmware configuration files (content of cfg_files directory) – These are Altera .ttf files for configuring the FPGA devices.

The list below identifies the role of each source module/C++ class (.cpp and/or .h file), separated into functional groups:

• Main/Initialisation/Cleanup

- o dsssmain main program that sets up the DSSS implementation and runs it.
- o dsssimpl DSSS Implementation which uses GUI description files and has the bulk of the receiver processing.
- ControlPanelInit Allows saving and restoring of control panel control values (uses ControlPanelInitFile.cfg).
- o CloseCatcher Catches keypress events.

• Plotting

- o IPlotDataSource Interface for plot data sources. Provides plot data types and methods for manipulating plot data sources.
- o PlotDataSourceDriver Implements IPlotDataSource. Supplies data requested by PlotRenderer from dsssDriver.
- o PlotDataSourceDriverSync Implements IPlotDataSource. Supplies data that has been synchronized from dsssDriver to PlotRenderer.
- o PlotDataSourceFile Implements IPlotDataSource. Loads data from a supplied file and passes the data to PlotRenderer.
- o PlotConfigFileReader Reads PlotConfigFile.cfg to obtain the different modes and data signals and passes them to PlotDataSourceDriver.
- o PlotRenderer Converts the raw plot data given to it into a collection of lines for plotting. Allows many different plot types and controls for the plot.
- o PlotCanvas Widget which shows lines that are calculated by PlotRenderer on a labelled Cartesian or polar grid.
- o PlotWindow Provides a separate window which uses PlotRenderer to show a plot in the window. Also includes some toolbars with plot controls.
- PowerSpectrumGenerator Used by Plot Renderer to convert blocks of timebased data to frequency-based data. Uses a FFT function (with window if desired) and scales the power spectrum to one of these formats: linear, dB, Power Spectral Density (dB) or dBm.

• Hardware Interface

- dsssDriver (dsssdriver) Interface to GBBM device driver. Allows DSSS application to read/write memory/registers on GBBM card via device file /dev/gbbm.
- o dsssRegisterList (initfile) Maintains a list of registers that are implemented in firmware (uses master.reg).
- "application"/"configuration" source (.cpp and .h files in application and cfg_sw directories)
 - o gbal_gbbm_fpga_cfg Allows configuration of Altera Stratix FPGA devices on the GBBM card.

- o gbal_gbbm_ts_cfg Allows configuration of the Maxim MAX1617 Temperature Sensor devices on the GBBM card
- *GBBM device driver* (.c and .h files in *driver* subdirectory):
 - This implements a Linux Device Driver for accessing the GBBM card with the following operations: open, release, read, write, ioctl, mmap and fasync.
 - o Most reading and writing of the GBBM card is done using the mmap
 - It relies on the existence of a device file at /dev/gbbm with major number 240.
 - The driver is compiled using the makefile and there are also targets for creating the device file (mkdev), loading the driver into the kernel (load) and unloading the driver from the kernel (unload). These 3 targets must be run as root.

Appendix A: Applicable System Configuration

This document applies only to a DSSS Receiver compliant with the following configuration descriptions.

A.1. Hardware configuration

- DPC Mainboard with serial number prefix 111368 or 118187.
- Slot#0: DDC with serial number prefix 111366 or 118187.
- Slot#1: DDP with serial number prefix 111367 or 118187.
- Slot#2 : Unloaded with JTAG chain bypassed, or loaded with a DDP that is unconfigured during DSSS operation.
- Slot#3: Unloaded with JTAG chain bypassed, or loaded with a DDP that is unconfigured during DSSS operation.

A.2. Firmware configuration

- PCI Target version : *pci_interface_15.sof*.
- DSSS Application version : *dsss_r1_0.ttf*.

The DSSS FW is further defined by the following extracts from the project compilation report produced by the Altera QuartusII development tools:

```
|-- sin_LUT:sin_IB
      -- dsss_demod:dsss
          |-- acq_ctrl_top:acq_control
                |-- acq_ctrl:acq_ctrl_1
                     |-- combiner:t1_score_combiner
                    -- combiner:t2_score_combiner
               |-- acq_holdup:acq_holdup_1
           |-- correlator_array_top:adv_time_corr
                |-- corr_array:corr_array1
           |-- demod_control:demod
                |-- despreader_v2:despreader_v2_1
                -- diffdet:diffdet_1
                     |-- cordic_rpc_v2:cordic_rpc_v2_1
                |-- eldll:eldll_1
                     -- cplx_corr_v2:ccv1
                     -- cplx_corr_v2:ccv2
                |-- freq_ctrl:freq_ctrl_1
                     |-- eavg:eavg1
                     -- rom:rom1
                -- pn_gen:pn_gen1
                     -- png:png1
                      -- spng:spng1
                      -- spng:spng2
                     -- png:tpni_png
                     -- png:tpnq_png
                -- str_v3:str_v3_1
                -- sym_clock:sym_clk
                -- sym_dec:sym_dec_1
           |-- fir_filter:FIR
                -- fsdet:fs_fsdet
                -- buff8:ia_out_buff8
                -- buff8:iadat buff8
                 -- buff8:ib_out_buff8
                -- buff8:ibdat_buff8
                -- fir01:ix_fir_fir01
                 -- buff8:qa_out_buff8
                 -- buff8:qadat_buff8
                 -- buff8:qb_out_buff8
                 -- buff8:qbdat_buff8
                -- fir01:qx_fir_fir01
           |-- interpolator_top:Interpolator
                -- agcc:agcc1
                 -- interpolator:interpolator1
                 -- interpolator:interpolator2
                -- specan_src_mux:specan_src_mux1
           |-- correlator_array_top:on_time_corr
                |-- corr_array:corr_array1
      |-- dsss_bitstream_if:dsss_bsif
           |-- bsif_ram:fifo_A
           -- bsif_ram:fifo_B
      -- dsss_membank:dsss_fifo
      -- dsss_pciif_regbank:dsss_regbank
      -- dsss_fifopacker:fifo_packer
      -- fsdet:fs_fsdet
      -- pbus_tgt_dsss:pciif
|-- dsss_lvdsif:lvdsif
 |-- dsss_tsif:tsif
     |-- temperature_sensor_interface:ts_wrap
            -- divide_by_N:clock_divider
           -- status_register:error_sr
           -- parallel_to_serial_converter:psc
           -- mux_2to1_8bit:readdata_mux
           -- serial_to_parallel_converter:spc
           -- tsi_sm:state_machine
           -- mux_2to1_1bit:writedata_mux
```

DSTO-GD-0525

Maximum chip rate: 50 MCPS.
Maximum data rate: 4 Mbps.
Maximum Ambient: 60° C.

A.3. Development GUI configuration

GUI code release : Version 3.Driver code release : Version 3.

Appendix B: DSSS Receiver Performance Profiles

Examples of the BER performance of the DSSS Receiver in an AWGN channel are provided in *Figure 10*. The curves typify two situations, one with a high data rate and hence a low processing gain, and one with a low data rate and hence a high processing gain. The roll-off in the latter case is introduced with the digital downconversion functions, and is being investigated.

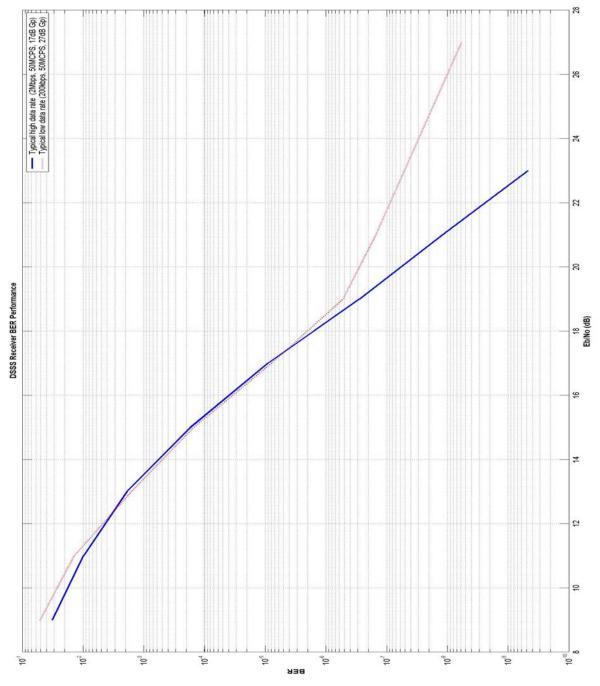


Figure 10- DSSS Receiver Performance Characteristics

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19. ABSTRACT

The direct-sequence spread-spectrum (DSSS) receiver performs demodulation of wideband DSSS signals, accepting as input an analogue signal at low intermediate frequency (IF) or baseband, and producing as output the recovered digital message bitstream. It consists of firmware (FW) entities that perform signal processing; a PCI-compliant digital processor card (DPC) that provides analogue to digital conversion and host resources for the FW; and a computer which hosts the DPC and runs software to access, control and monitor it. This manual provides the information required to allow an operator to connect, configure and dynamically control the DSSS Receiver in a precise way to achieve the best demodulation performance.

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